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**English et al.**

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(54) **CIRCUITS FOR CONTROLLING DISPLAY APPARATUS**

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(57)

**ABSTRACT**

An apparatus includes a plurality of display elements arranged in an array and a control matrix coupled to the plurality of display elements to communicate data and drive voltages to the display elements. For each display element, the control matrix includes an actuation circuit coupling a voltage source to the display element. The control matrix is configured to apply an actuation voltage to an actuator of the display element throughout an actuation stroke of the actuator and to initiate the actuation of the actuator after a pre-charging signal that initiated the application of the actuation voltage to the actuator has been deactivated.

**32 Claims, 15 Drawing Sheets**

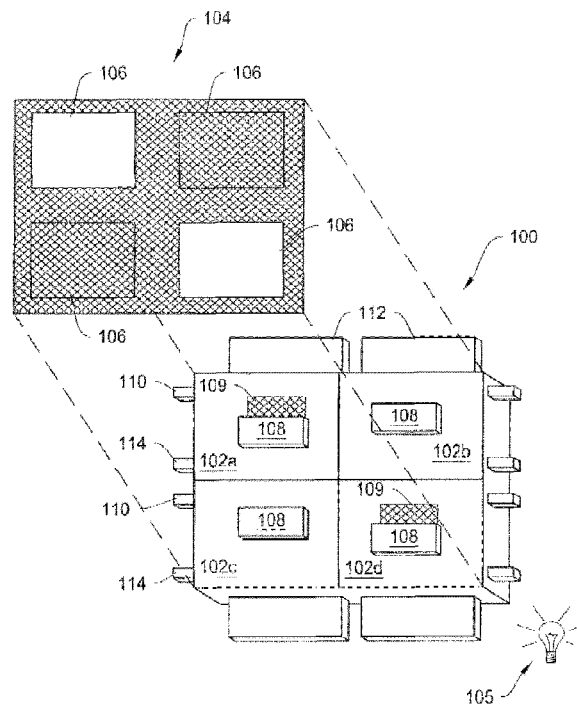
(51) **Int. Cl.**  
**G09G 3/34** (2006.01)

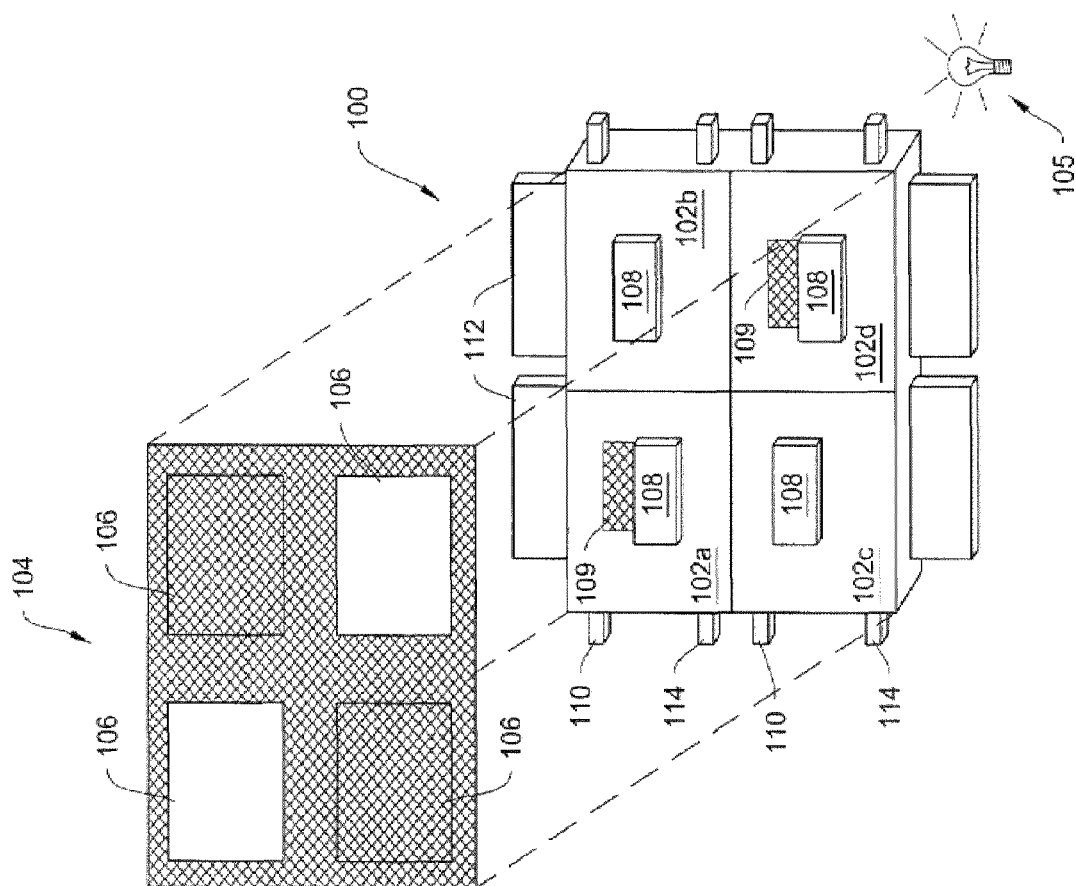
(52) **U.S. Cl.**  
CPC ..... **G09G 3/3433** (2013.01); **G09G 3/3473** (2013.01); **G09G 3/348** (2013.01); **G09G 2300/0809** (2013.01); **G09G 2310/0251** (2013.10); **G09G 2320/0252** (2013.01); **G09G 2330/021** (2013.01)

(58) **Field of Classification Search**

None

See application file for complete search history.





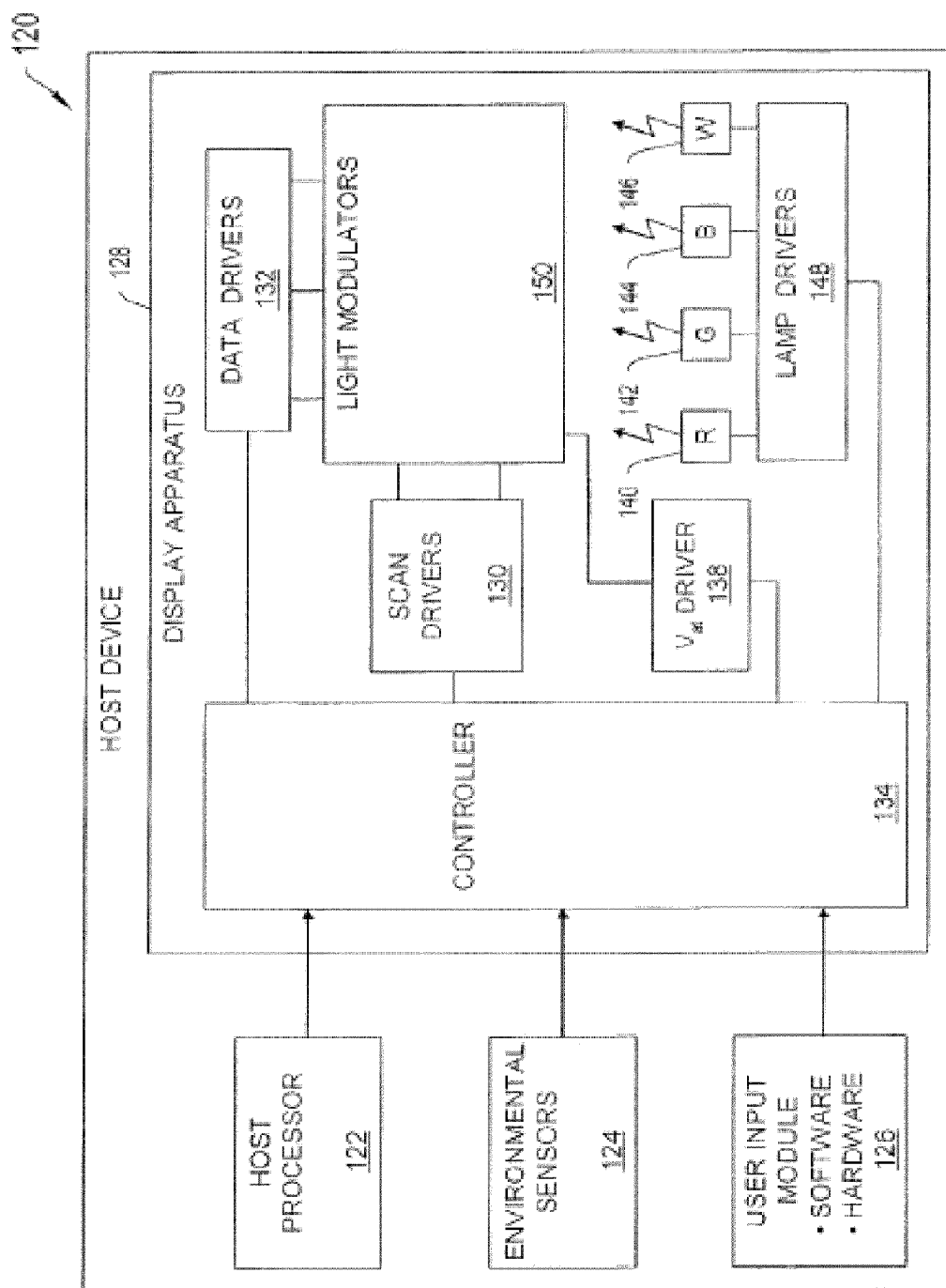


FIGURE 1B

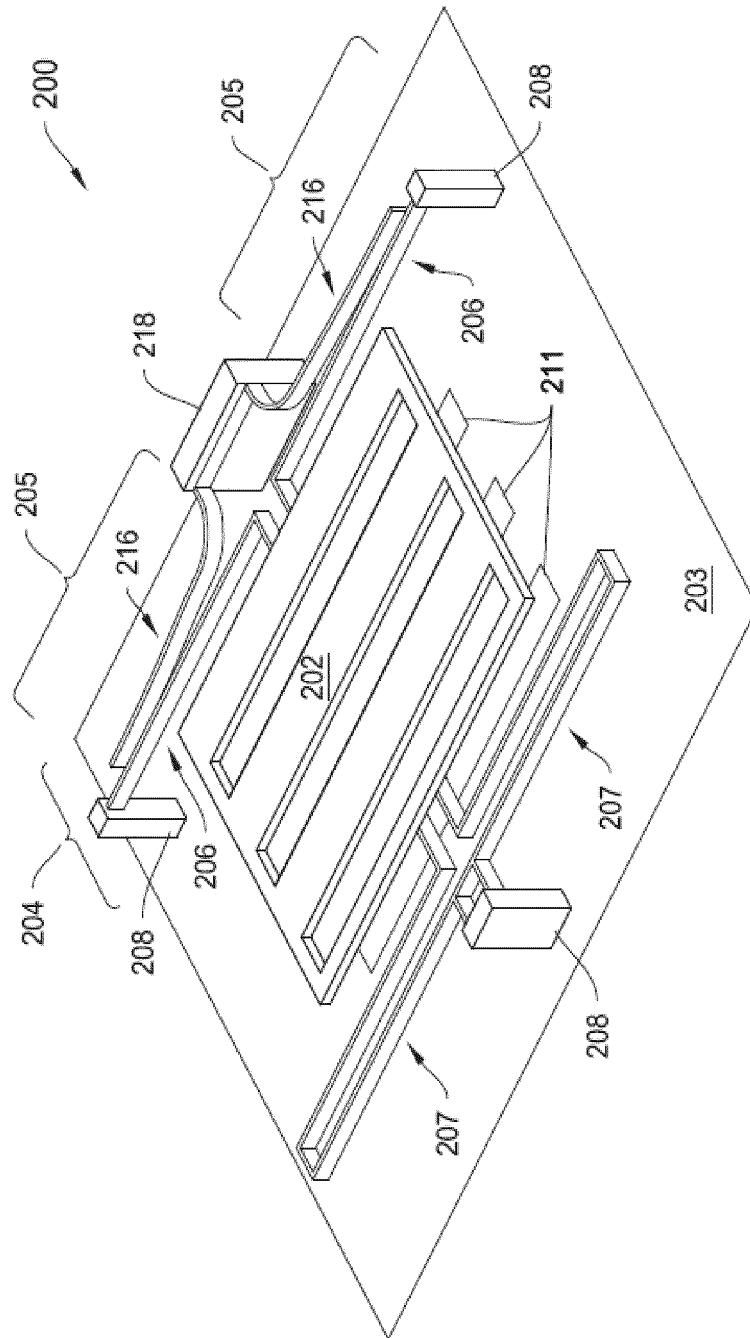


FIGURE 2A

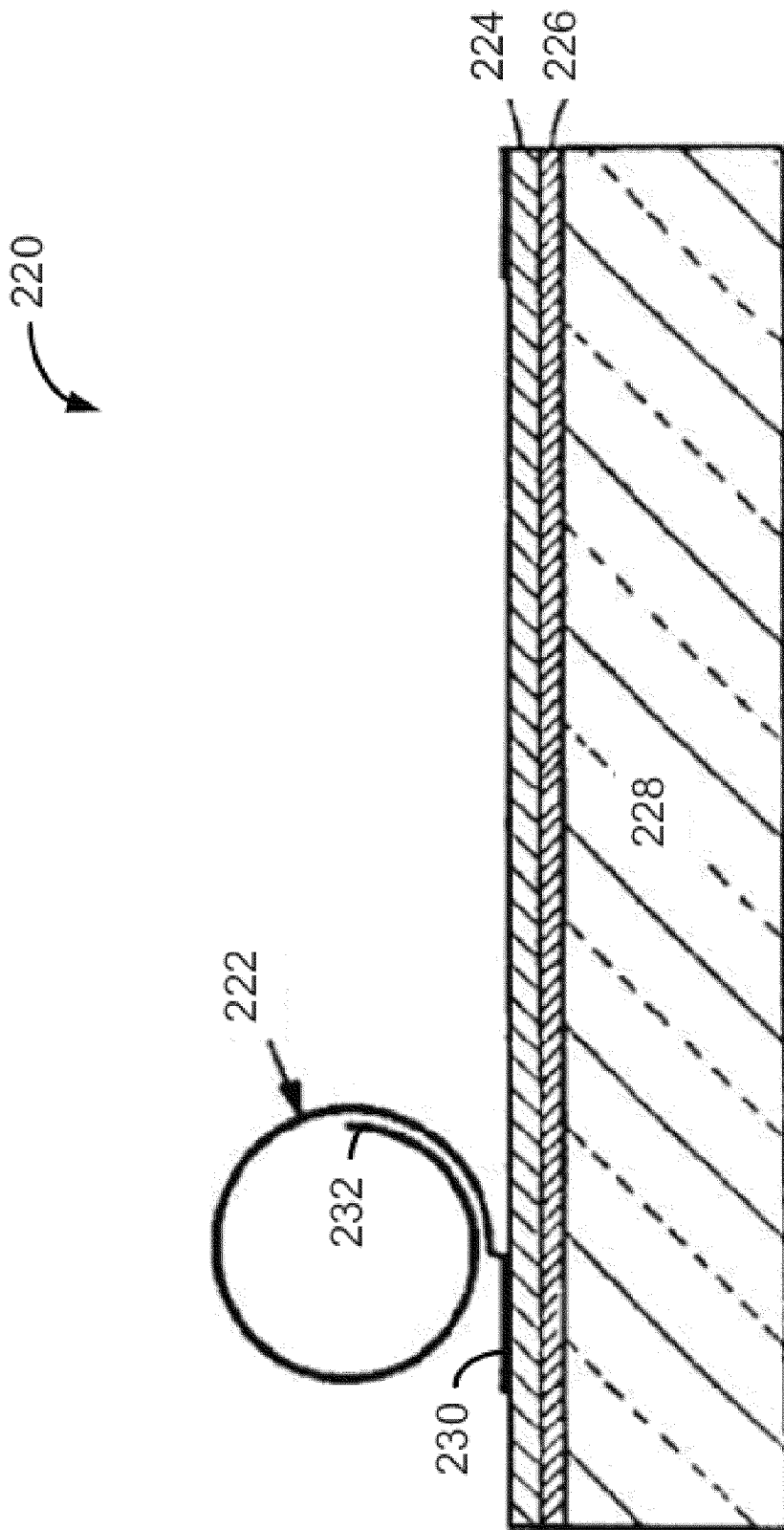


FIGURE 2B

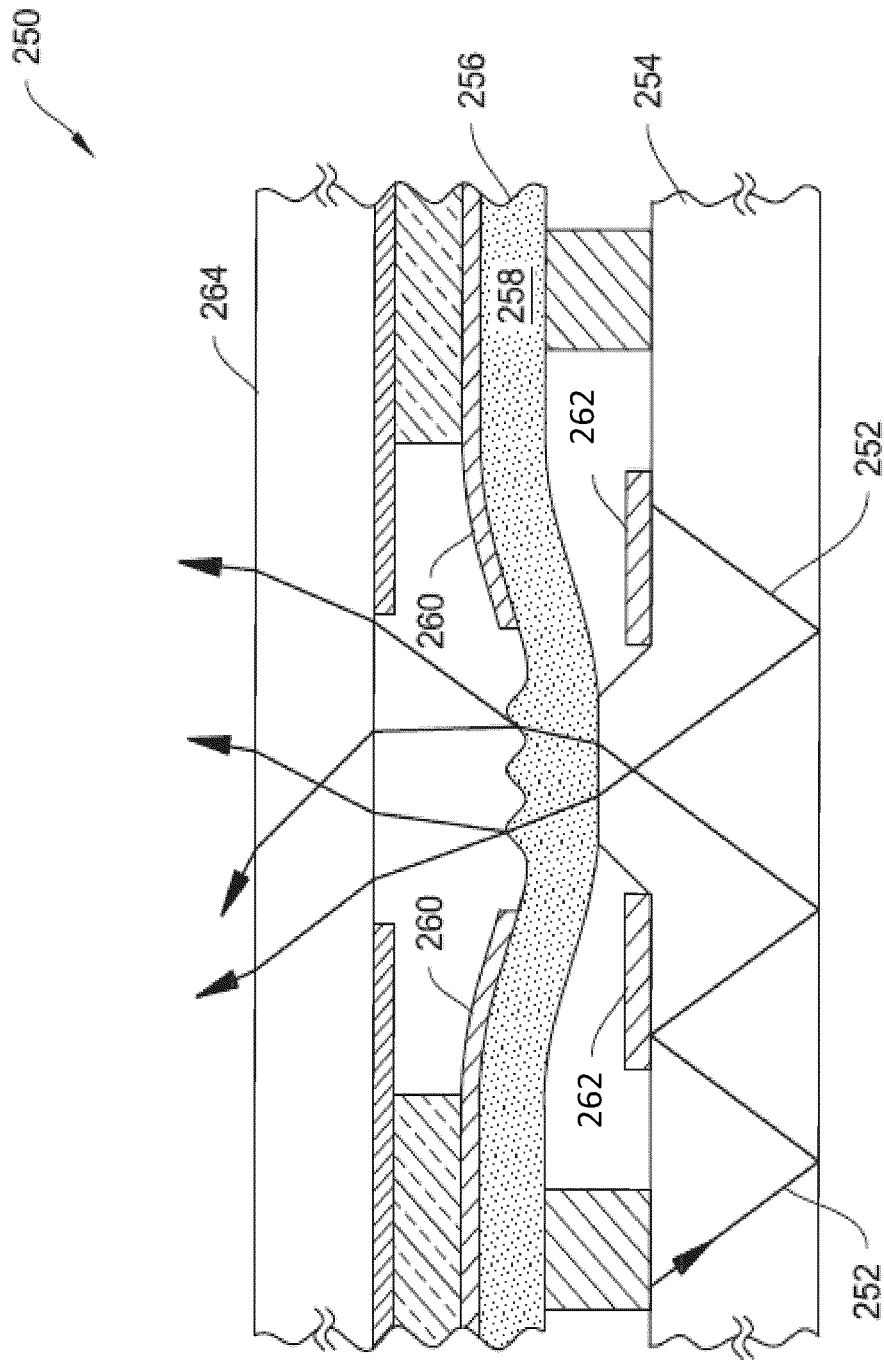


FIGURE 2C

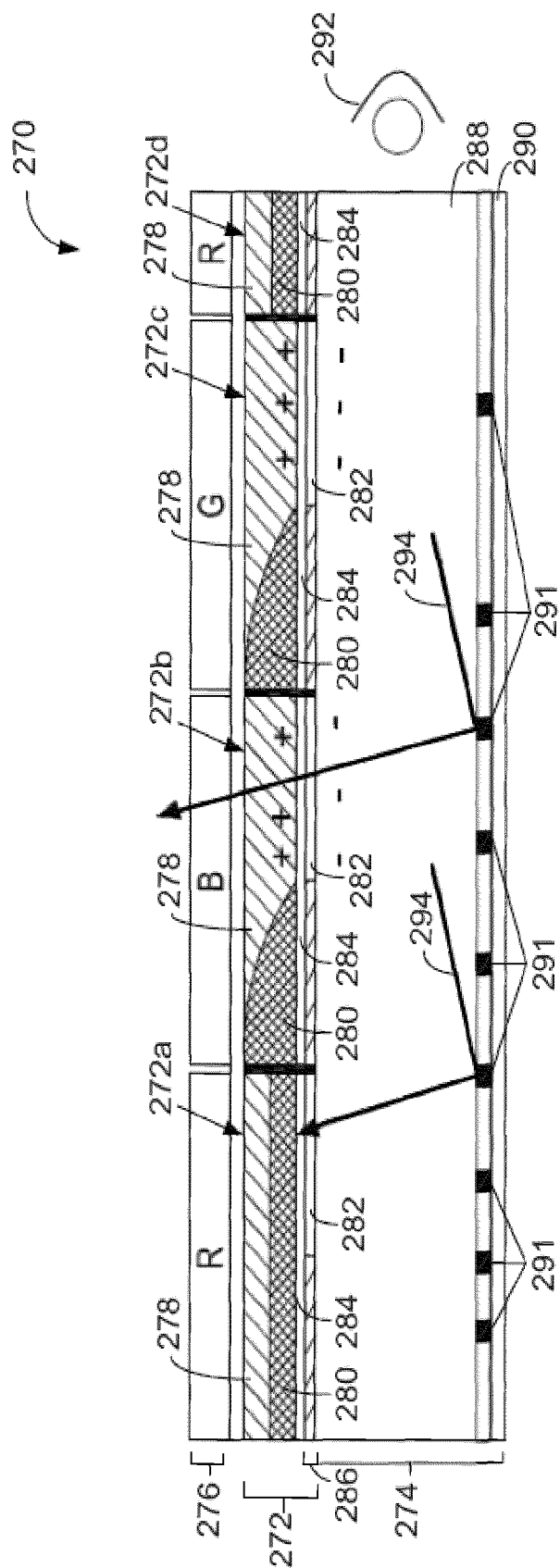


FIGURE 2D

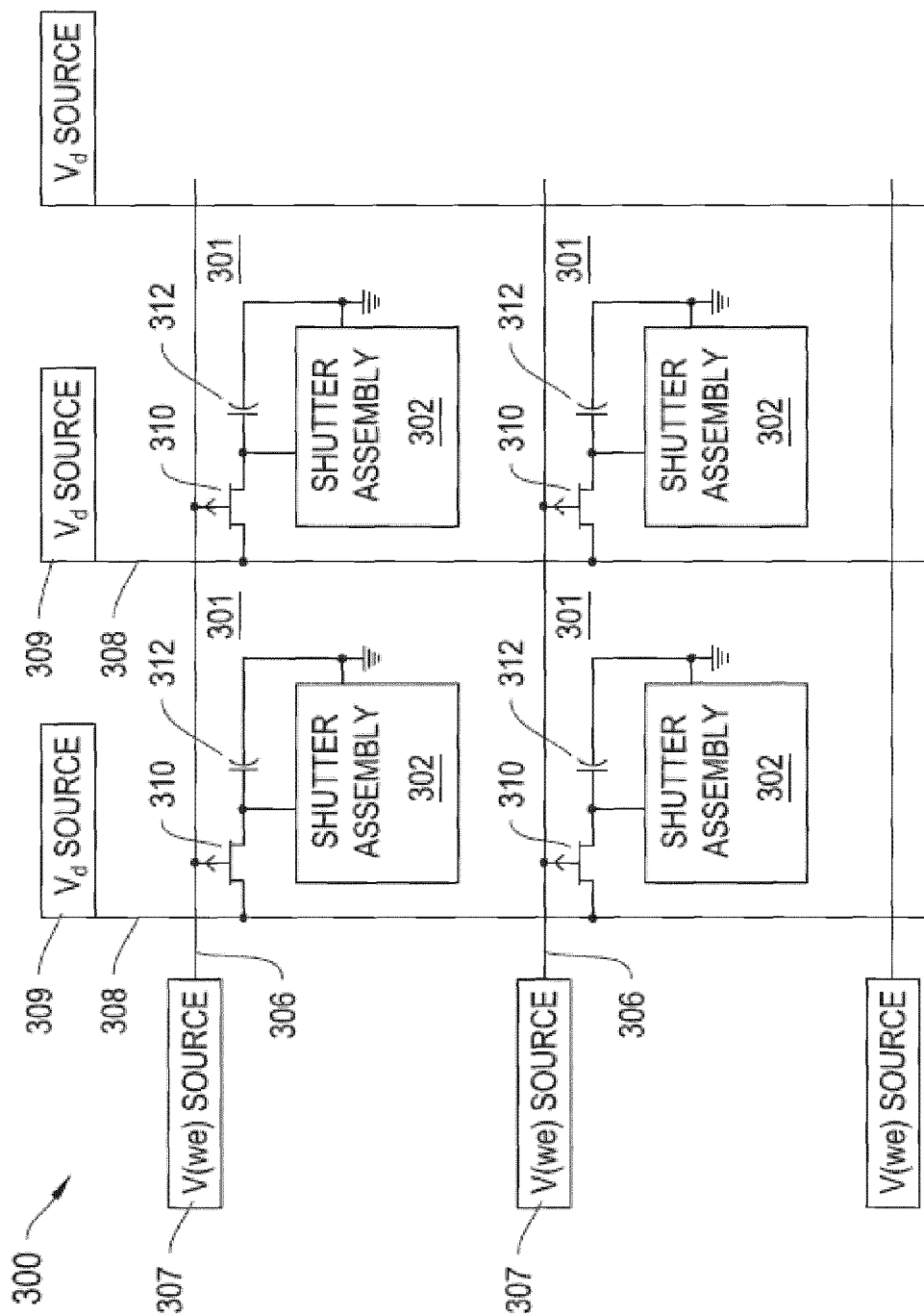


FIGURE 3A



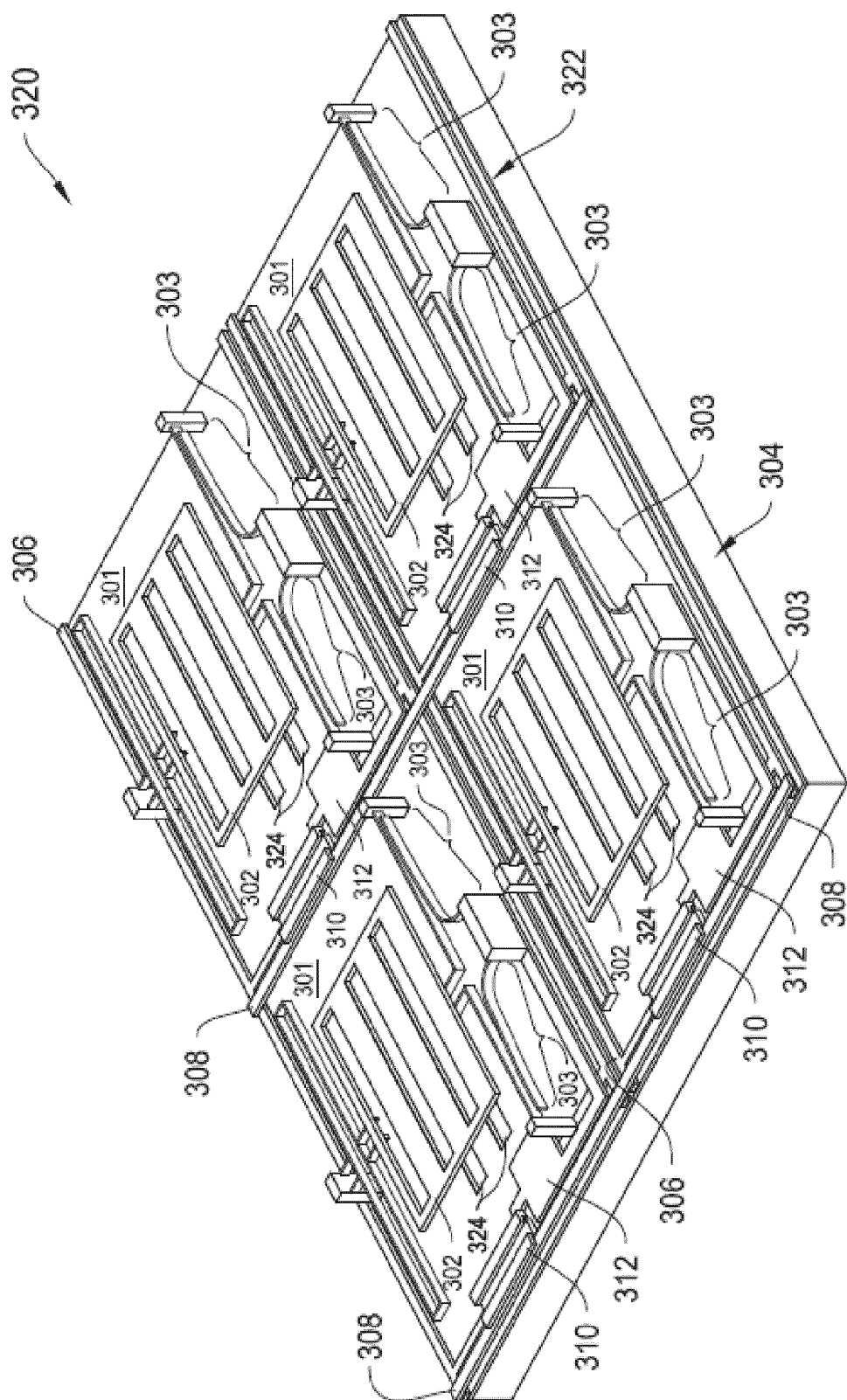


FIGURE 3B

FIGURE 4A

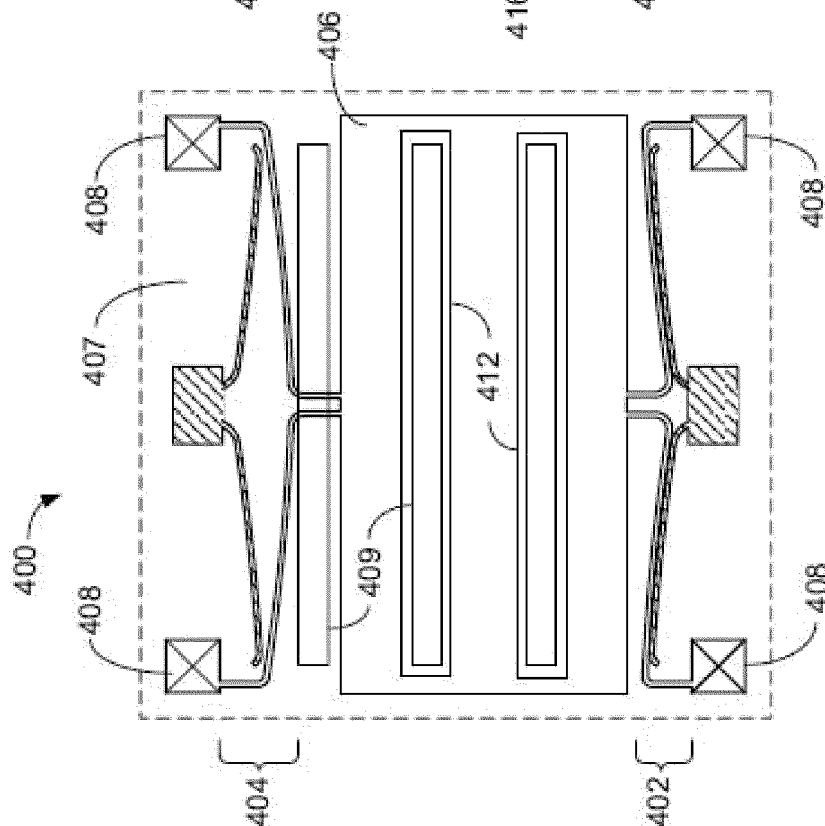
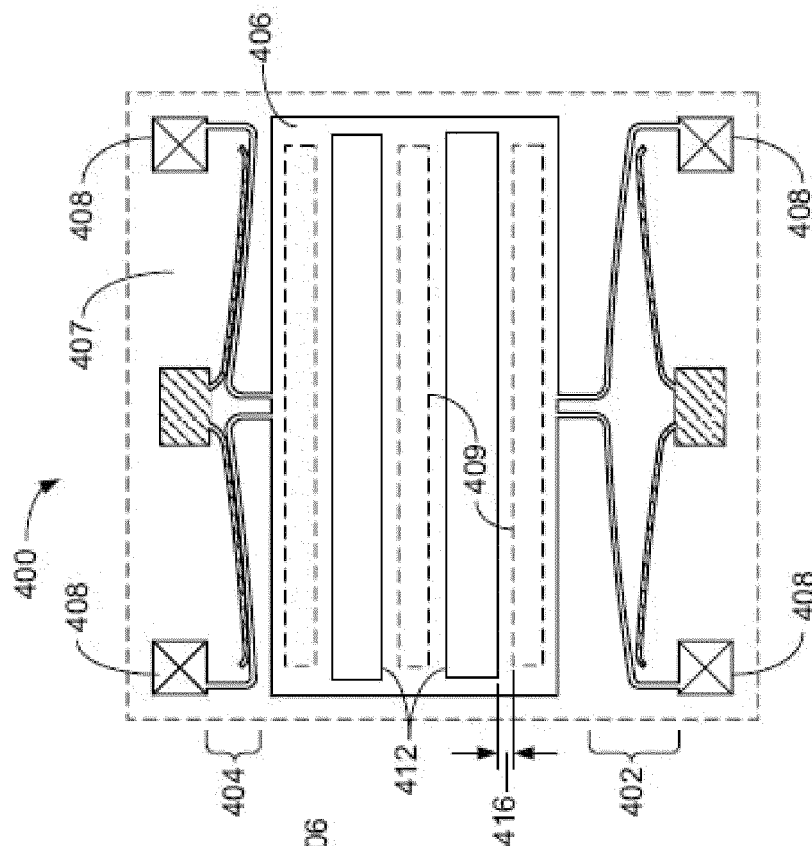


FIGURE 4B



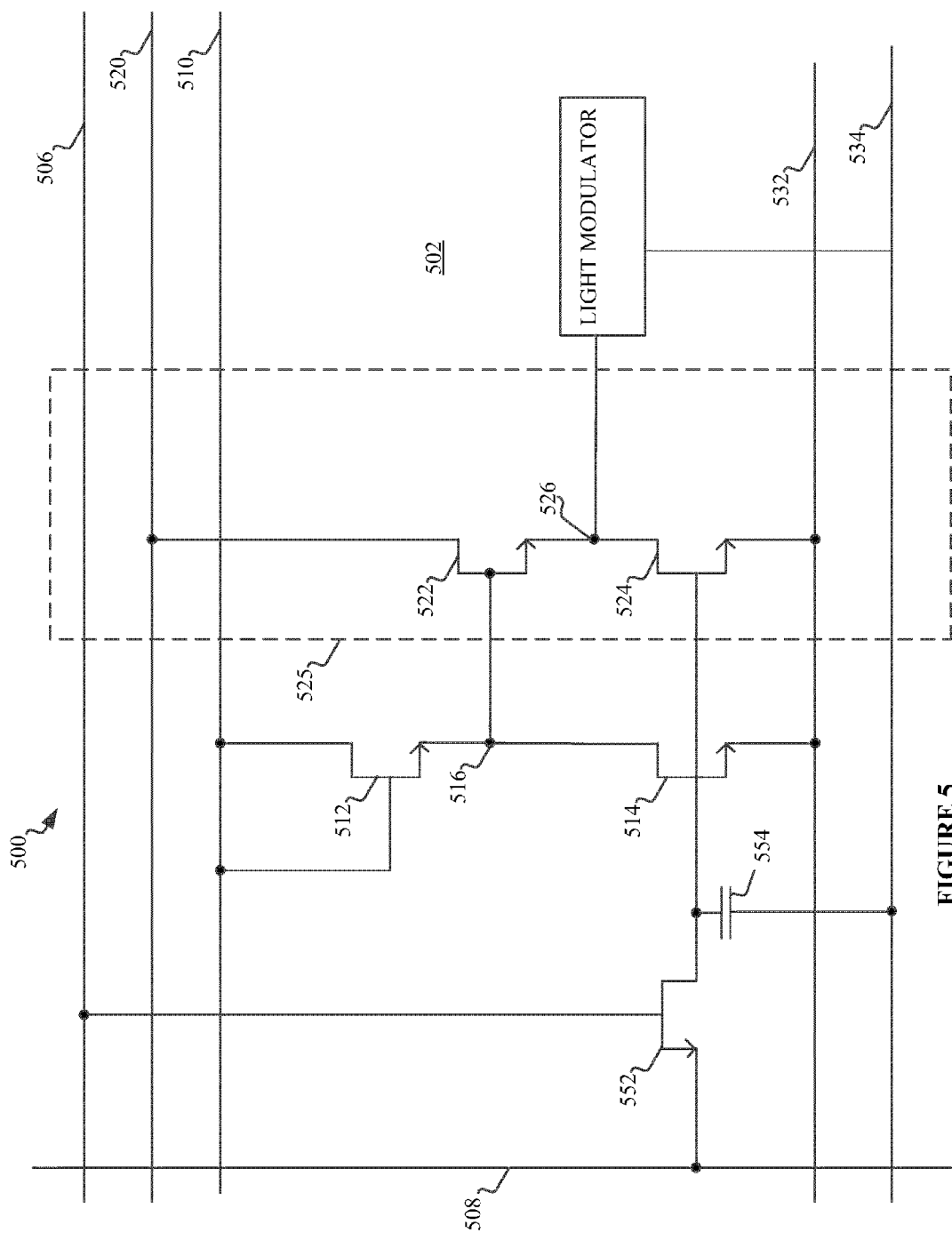


FIGURE 5

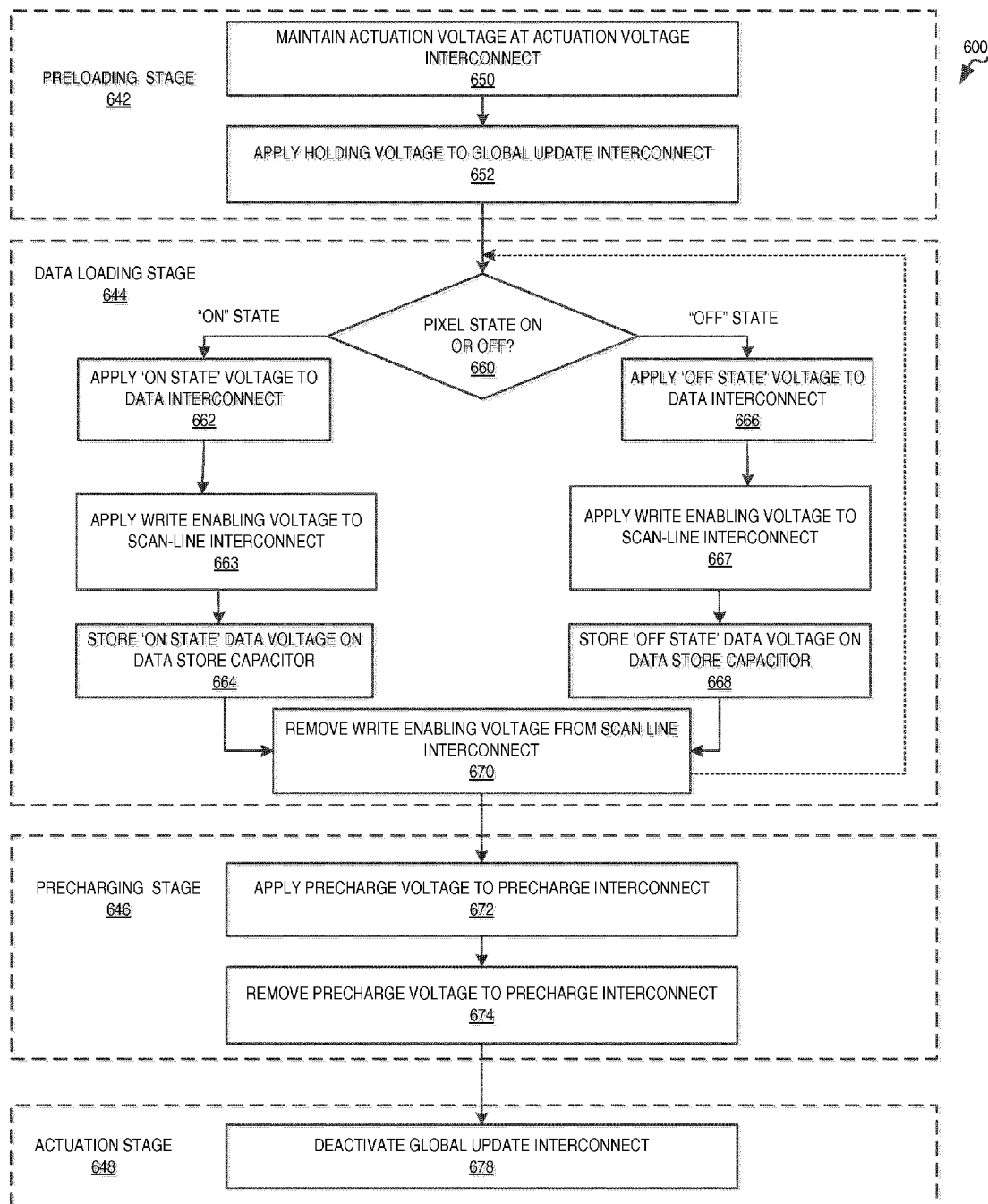


FIGURE 6

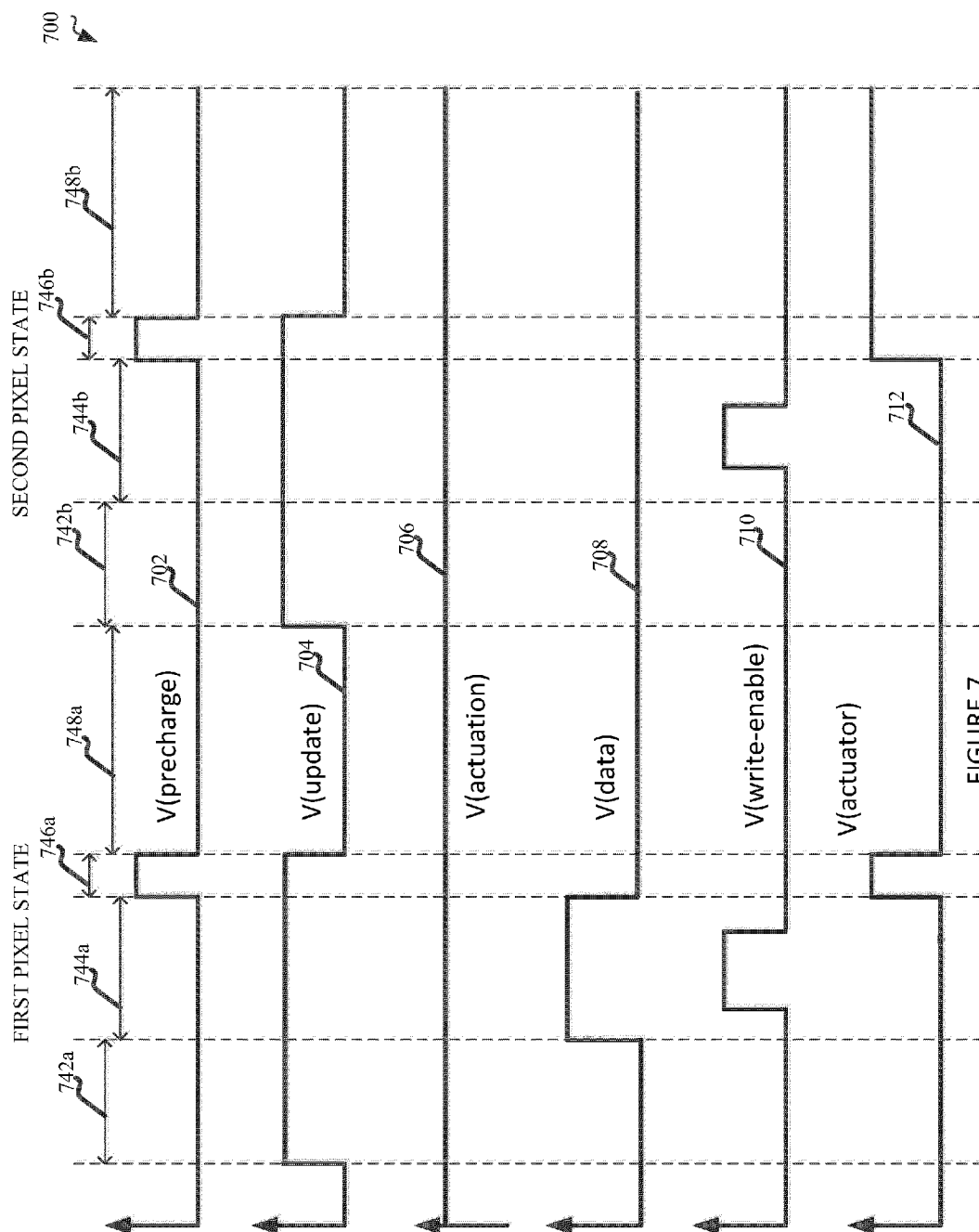


FIGURE 7

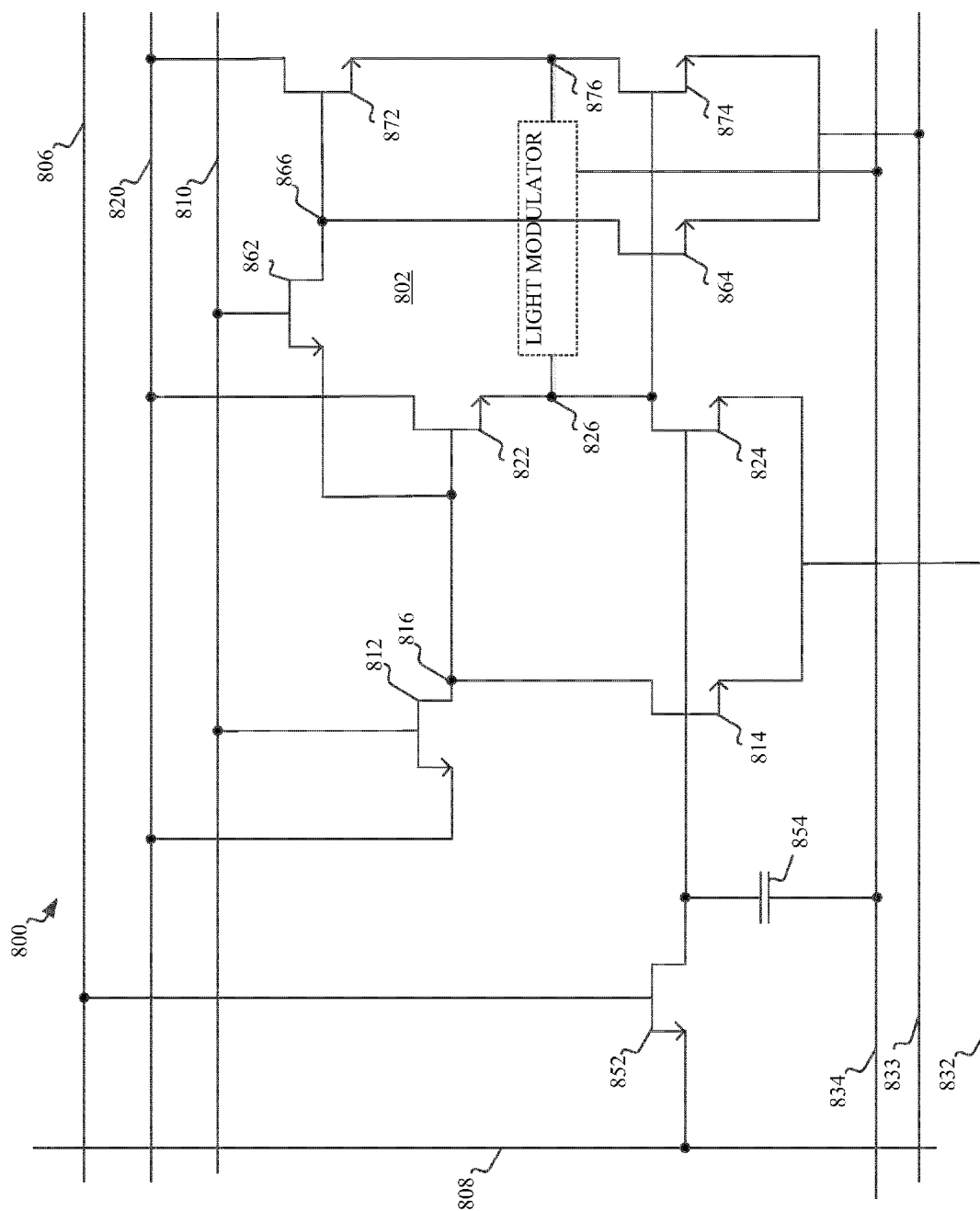


FIGURE 8

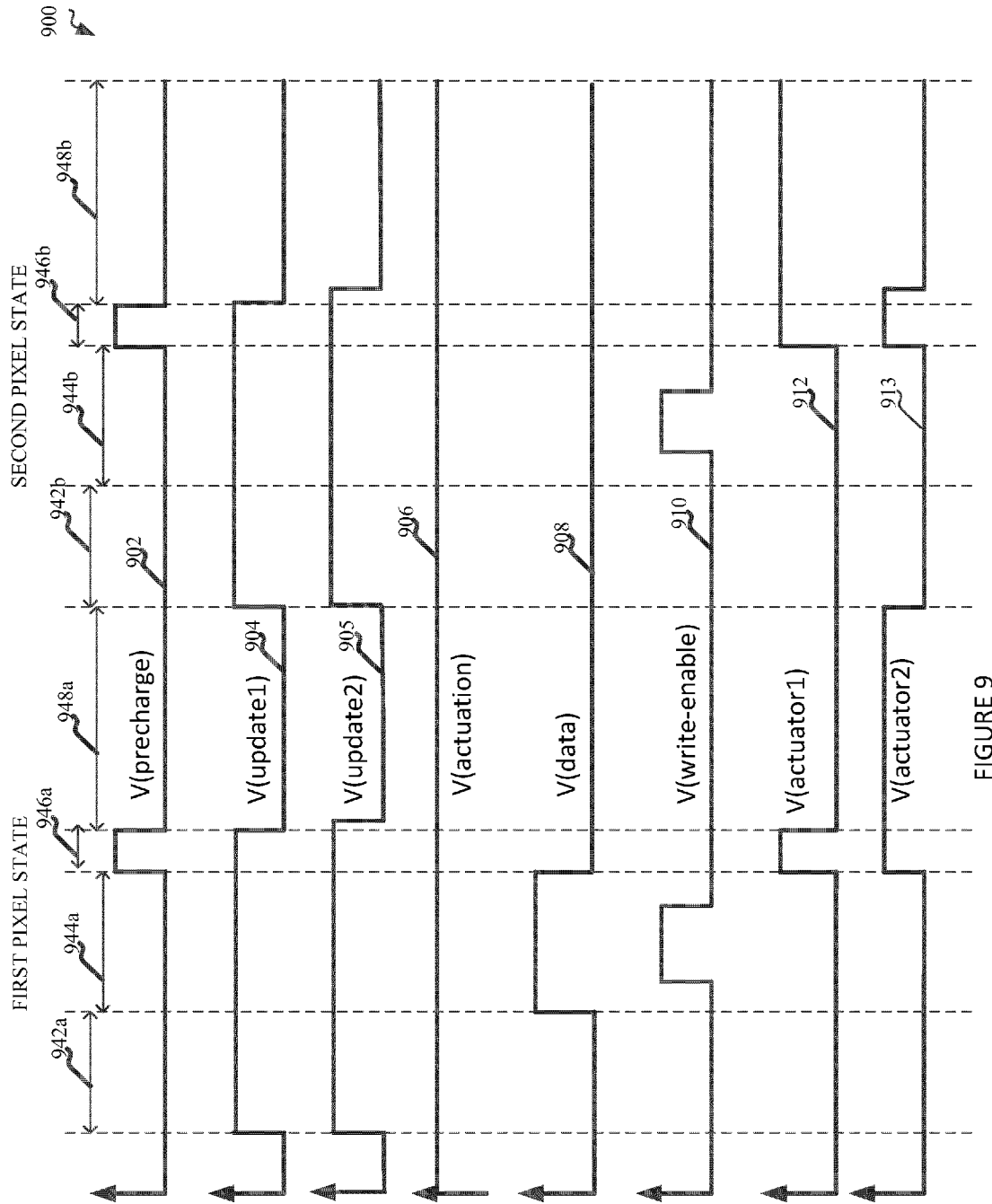


FIGURE 9

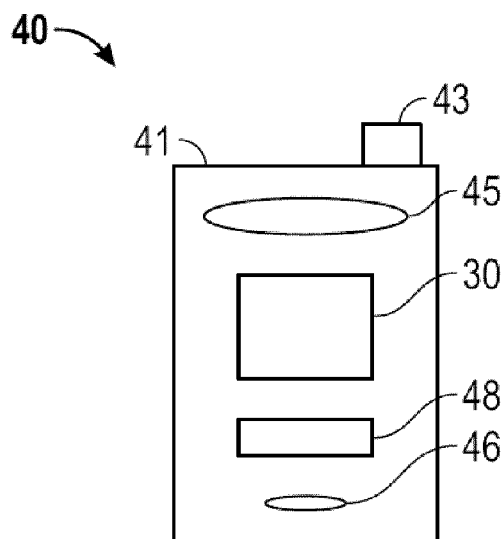


FIGURE 10A

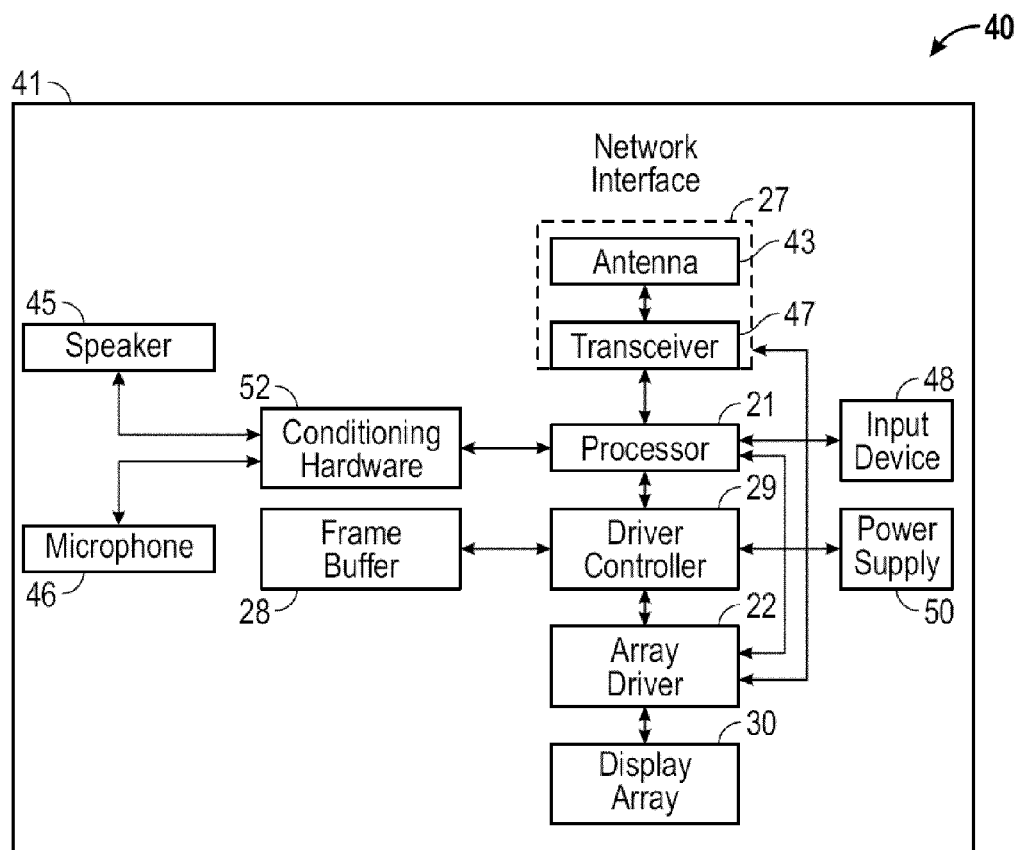


FIGURE 10B



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## CIRCUITS FOR CONTROLLING DISPLAY APPARATUS

### TECHNICAL FIELD

This disclosure relates to the field of electromechanical systems (EMS). In particular, this disclosure relates to circuits for controlling an array of EMS display elements of a display apparatus to generate display images.

### DESCRIPTION OF THE RELATED TECHNOLOGY

Various display apparatus include an array of display pixels that have corresponding light modulators that transmit or reflect light to form images. The light modulators include actuators for driving the light modulators between a first state and a second opposite state. In certain display apparatus, it is desirable to increase the speed and reliability of the light modulators. The light modulators are controlled by a collection of circuits referred to as control matrix.

### SUMMARY

The systems, methods and devices of the disclosure each have several innovative aspects, no single one of which is solely responsible for the desirable attributes disclosed herein.

One innovative aspect of the subject matter described in this disclosure can be implemented in an apparatus that includes a plurality of display elements arranged in an array and a control matrix coupled to the plurality of EMS display elements to communicate data and drive voltages to the display elements. For each display element, the control matrix includes an actuation circuit coupling a voltage source to the display element. The control matrix is configured to apply an actuation voltage to an actuator of the display element throughout an actuation stroke of the actuator and to initiate the actuation of the actuator after a pre-charging signal that initiated the application of the actuation voltage to the actuator has been deactivated.

In some implementations, the actuation circuit is coupled to a global update interconnect and the actuation circuit is configured to selectively remove the actuation voltage applied to the actuator in response to activation of the global update interconnect. In some implementations, the actuation circuit includes an actuation discharge transistor coupled to the global update interconnect and the actuation voltage is removed by being discharged through the actuation discharge transistor. In some implementations, the actuation circuit includes a source follower circuit.

In some implementations, the actuation discharge transistor is selectively actuated based on a data voltage stored at the data store. In some implementations, the actuation circuit is governed by the pre-charging signal on a pre-charge node. The pre-charge node is coupled to a pre-charge voltage source that activates the pre-charging signal. In some implementations, the pre-charge voltage on the pre-charge node for the display element is controlled by the pre-charge signal voltage source and a pre-charge discharge switch that maintains the voltage on the pre-charge node provided by the pre-charge signal voltage source until the pre-charge discharge switch is activated.

In some implementations, the control matrix also includes a second actuation circuit coupling the voltage source to the display element and configured to apply the actuation voltage to a second actuator of the display element throughout a

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second actuation stroke of the actuator in a direction different from the first actuation stroke. In some such implementations, the control matrix is configured to initiate the actuation of the second actuator after a second pre-charging signal that initiated the application of the actuation voltage to the second actuator has been deactivated. In some implementations, the control matrix is configured to actuate the actuator by activating the global update interconnect prior to actuating the second actuator by activating the second global update interconnect. In some implementations, the control matrix is configured to actuate the second actuator by activating the second global update interconnect prior to actuating the actuator by activating the global update interconnect.

In some implementations, the second actuation circuit is coupled to a second global update interconnect. The second actuation circuit is configured to selectively remove the actuation voltage applied to the second actuator in response to activation of the second global update interconnect. In some implementations, the actuation circuit includes an actuation discharge transistor coupled to the second global update interconnect and the actuation voltage is removed by being discharged through the actuation discharge transistor. In some implementations, the second actuation discharge transistor is selectively actuated based on an output of the actuation discharge transistor.

In some implementations, the control matrix includes only n-type transistors. In some implementations, the control matrix includes only p-type transistors. In some implementations, the apparatus includes a display apparatus and the display elements are light modulators. In some implementations, the display elements are electromechanical system (EMS) display elements. In some implementations, the display elements are microelectromechanical system (MEMS) display elements.

In some implementations, the apparatus includes a display. The apparatus also includes a processor that is configured to communicate with the display and configured to process image data. The apparatus also includes a memory device that is configured to communicate with the processor. In some implementations, the apparatus also includes a driver circuit configured to send at least one signal to the display. In some such implementations, the controller is further configured to send at least a portion of the image data to the driver circuit. In some implementations, the apparatus includes an image source module configured to send the image data to the processor. In some such implementations, the image source module includes at least one of a receiver, transceiver, and transmitter. In some implementations, the apparatus includes an input device configured to receive input data and to communicate the input data to the processor.

Another innovative aspect of the subject matter described in this disclosure can be implemented in a display apparatus that includes a plurality of display elements arranged in an array and a control matrix coupled to the plurality of display elements to communicate data and drive voltages to the display elements. For each display element, the control matrix includes a first actuation circuit that couples a voltage source to the display element and is configured to apply an actuation voltage to a first actuator of the display element throughout an actuation stroke of the first actuator. The control matrix also includes a second actuation circuit that couples the voltage source to the display element and is configured to apply the actuation voltage to a second actuator of the display element throughout an actuation stroke of the second actuator. The control matrix is configured to initiate the actuation of one of the first actuator and the second actuator after a pre-charging

signal that initiated the application of the actuation voltage to the first actuator and the second actuator has been deactivated.

In some implementations, the first actuation circuit is coupled to a first global update interconnect and the first actuation circuit is configured to selectively remove the actuation voltage applied to the first actuator in response to deactivation of the first global update interconnect. In some such implementations, the second actuation circuit is coupled to a second global update interconnect and the second actuation circuit is configured to selectively remove the actuation voltage applied to the first actuator in response to deactivation of the second global update interconnect.

In some implementations, the control matrix is configured to actuate one of the first actuator and the second actuator in response to the deactivation one of the first global update interconnect and the second global update interconnect prior to the deactivation of the other of the first global update interconnect and the second global update interconnect. In some implementations, the control matrix is configured to actuate one of the first actuator and the second actuator based on a data voltage stored at the data store. In some implementations, the first actuator circuit and the second actuator circuit are governed by the pre-charging signal on a pre-charge node, the pre-charge node coupled to a pre-charge voltage source that activates the pre-charging signal.

In some implementations, the control matrix includes only n-type transistors. In some implementations, the control matrix includes only p-type transistors. In some implementations, the apparatus includes a display apparatus and the display elements are light modulators. In some implementations, the display elements are electromechanical system (EMS) display elements. In some implementations, the display elements are microelectromechanical system (MEMS) display elements.

Details of one or more implementations of the subject matter described in this specification are set forth in the accompanying drawings and the description below. Although the examples provided in this summary are primarily described in terms of EMS-based displays, MEMS-based displays, the concepts provided herein may apply to other types of displays, such as LCD, OLED, electrophoretic, and field emission displays, as well as to other non-display EMS devices or MEMS devices, such as MEMS microphones, sensors, and optical switches. Other features, aspects, and advantages will become apparent from the description, the drawings, and the claims. Note that the relative dimensions of the following figures may not be drawn to scale.

#### BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1A shows an example schematic diagram of a direct-view MEMS-based display apparatus.

FIG. 1B shows an example block diagram of a host device.

FIG. 2A shows an example perspective view of an illustrative shutter-based light modulator.

FIG. 2B shows a cross sectional view of a rolling actuator shutter-based light modulator.

FIG. 2C shows a cross sectional view of an illustrative non shutter-based microelectromechanical systems (MEMS) light modulator.

FIG. 2D shows a cross sectional view of an electrowetting-based light modulation array.

FIG. 3A shows an example schematic diagram of a control matrix.

FIG. 3B shows a perspective view of an array of shutter-based light modulators connected to the control matrix of FIG. 3A.

FIGS. 4A and 4B show example views of a dual actuator shutter assembly.

FIG. 5 shows a portion of an example control matrix.

FIG. 6 shows a flow diagram of an example frame addressing and pixel actuation method.

FIG. 7 shows a timing diagram of example voltages applied to various interconnects of a control matrix.

FIG. 8 shows a portion of another example control matrix.

FIG. 9 shows a timing diagram of example voltages applied to various interconnects of a control matrix.

FIGS. 10A and 10B are system block diagrams illustrating a display device that includes a plurality of display elements.

Like reference numbers and designations in the various drawings indicate like elements.

#### DETAILED DESCRIPTION

This disclosure relates to circuits for controlling an array of display elements of a display apparatus to generate images on the display. In some implementations, the display elements may be electromechanical systems (EMS) display elements or microelectromechanical systems (MEMS) display elements. In some implementations, the display elements may be light modulators. In some implementations, each display element, such as a light modulator corresponds to a display pixel. Certain display apparatus include light modulators that include one or more actuators for driving the light modulators into a first state, such as an ON state, in which the light modulator transmits light and a second state, such as an OFF state, in which the light modulator does not output any light. The circuits used to drive the actuators described above are arranged into a control matrix. The control matrix addresses each pixel of the array to either be in an ON state corresponding to an ON state for a corresponding light modulator or an OFF state corresponding to the OFF state of the corresponding light modulator for any given image frame. For increased speed of light modulator actuation with reduced power consumption, it is beneficial to electrostatically actuate a light modulator with a voltage source rather than with a stored electrical charge on a "pre-charged" node. Doing so has proven difficult with pixels that have only one kind of transistor (e.g., only P-MOS or N-MOS) with no standing current (other than device leakage currents).

In some implementations, as the light modulator engages an actuator, the light modulator works against a spring that produces more opposing force as the light modulator is engaged. In addition, the fluid surrounding the actuator and the light modulator hinders the movement of the light modulator towards the actuator due to the squeeze film damping of fluid being forced out from between opposing portions of the actuator. This tends to slow down the light modulator transition time and reduce the efficiency and visual quality of the display. Providing an actuation force that increases through the actuation stroke can help counter the increasing spring force and squeeze film damping effects. The term "actuation stroke," as used herein refers to the distance traveled by the light modulating component during actuation.

To address this desire for increased actuation force, the actuator can be actively coupled to a voltage source to maintain a substantially constant voltage across the actuator throughout the actuation stroke, even as the capacitance of the actuator increases. Such a configuration yields an increase in force by the inverse square of the distance of engagement of the shutter with the actuator, thus helping overcome the retarding forces of the spring and squeeze film damping.

To maintain the active coupling, the display apparatus includes a control matrix, which for each pixel includes a

switch that couples a voltage source to the pixel. The switch is configured to apply an actuation voltage output by the voltage source to an actuator of the pixel throughout an actuation stroke of the actuator. In some implementations, the switch can be a source-follower transistor governed by a pre-charge voltage applied to and then stored on a pre-charge node. The voltage on the pre-charge node is controlled by a pre-charge voltage on a pre-charge interconnect and a discharge switch. The control matrix also includes a data store for each pixel. The discharge switch maintains the voltage on the pre-charge node provided by the pre-charge voltage interconnect until the discharge switch is activated in response to a data voltage stored on the data store.

Particular implementations of the subject matter described in this disclosure can be implemented to realize one or more of the following potential advantages. By maintaining an active coupling between the actuator and the voltage source, the shutter can be actuated with increased speeds and greater accuracy, while consuming less power. The increased speed improves the light modulator transition time, thereby improving efficiency and visual quality of the display. Further, since the implementations described herein do not have standing currents during operation, the light modulators can be actuated while consuming less power. As a result, such implementations can be used for low power display operation.

FIG. 1A shows a schematic diagram of a direct-view MEMS-based display apparatus 100. The display apparatus 100 includes a plurality of light modulators 102a-102d (generally “light modulators 102”) arranged in rows and columns. In the display apparatus 100, the light modulators 102a and 102d are in the open state, allowing light to pass. The light modulators 102b and 102c are in the closed state, obstructing the passage of light. By selectively setting the states of the light modulators 102a-102d, the display apparatus 100 can be utilized to form an image 104 for a backlit display, if illuminated by a lamp or lamps 105. In another implementation, the apparatus 100 may form an image by reflection of ambient light originating from the front of the apparatus. In another implementation, the apparatus 100 may form an image by reflection of light from a lamp or lamps positioned in the front of the display, i.e., by use of a front light.

In some implementations, each light modulator 102 corresponds to a pixel 106 in the image 104. In some other implementations, the display apparatus 100 may utilize a plurality of light modulators to form a pixel 106 in the image 104. For example, the display apparatus 100 may include three color-specific light modulators 102. By selectively opening one or more of the color-specific light modulators 102 corresponding to a particular pixel 106, the display apparatus 100 can generate a color pixel 106 in the image 104. In another example, the display apparatus 100 includes two or more light modulators 102 per pixel 106 to provide luminance level in an image 104. With respect to an image, a “pixel” corresponds to the smallest picture element defined by the resolution of image. With respect to structural components of the display apparatus 100, the term “pixel” refers to the combined mechanical and electrical components utilized to modulate the light that forms a single pixel of the image.

The display apparatus 100 is a direct-view display in that it may not include imaging optics typically found in projection applications. In a projection display, the image formed on the surface of the display apparatus is projected onto a screen or onto a wall. The display apparatus is substantially smaller than the projected image. In a direct view display, the user sees the image by looking directly at the display apparatus,

which contains the light modulators and optionally a back-light or front light for enhancing brightness and/or contrast seen on the display.

Direct-view displays may operate in either a transmissive or reflective mode. In a transmissive display, the light modulators filter or selectively block light which originates from a lamp or lamps positioned behind the display. The light from the lamps is optionally injected into a lightguide or “back-light” so that each pixel can be uniformly illuminated. Transmissive direct-view displays are often built onto transparent or glass substrates to facilitate a sandwich assembly arrangement where one substrate, containing the light modulators, is positioned directly on top of the backlight.

Each light modulator 102 can include a shutter 108 and an aperture 109. To illuminate a pixel 106 in the image 104, the shutter 108 is positioned such that it allows light to pass through the aperture 109 towards a viewer. To keep a pixel 106 unlit, the shutter 108 is positioned such that it obstructs the passage of light through the aperture 109. The aperture 109 is defined by an opening patterned through a reflective or light-absorbing material in each light modulator 102.

The display apparatus also includes a control matrix connected to the substrate and to the light modulators for controlling the movement of the shutters. The control matrix includes a series of electrical interconnects (e.g., interconnects 110, 112 and 114), including at least one write-enable interconnect 110 (also referred to as a “scan-line interconnect”) per row of pixels, one data interconnect 112 for each column of pixels, and one common interconnect 114 providing a common voltage to all pixels, or at least to pixels from both multiple columns and multiples rows in the display apparatus 100. In response to the application of an appropriate voltage (the “write-enabling voltage,  $V_{WE}$ ”), the write-enable interconnect 110 for a given row of pixels prepares the pixels in the row to accept new shutter movement instructions. The data interconnects 112 communicate the new movement instructions in the form of data voltage pulses. The data voltage pulses applied to the data interconnects 112, in some implementations, directly contribute to an electrostatic movement of the shutters. In some other implementations, the data voltage pulses control switches, e.g., transistors or other non-linear circuit elements that control the application of separate actuation voltages, which are typically higher in magnitude than the data voltages, to the light modulators 102. The application of these actuation voltages then results in the electrostatic driven movement of the shutters 108.

FIG. 1B shows an example of a block diagram 120 of a host device (i.e., cell phone, smart phone, PDA, MP3 player, tablet, e-reader, etc.). The host device includes a display apparatus 128, a host processor 122, environmental sensors 124, a user input module 126, and a power source.

The display apparatus 128 includes a plurality of scan drivers 130 (also referred to as “write enabling voltage sources”), a plurality of data drivers 132 (also referred to as “data voltage sources”), a controller 134, common drivers 138, lamps 140-146, lamp drivers 148 and light modulators 150. The scan drivers 130 apply write enabling voltages to scan-line interconnects 110. The data drivers 132 apply data voltages to the data interconnects 112.

In some implementations of the display apparatus, the data drivers 132 are configured to provide analog data voltages to the light modulators, especially where the luminance level of the image 104 is to be derived in analog fashion. In analog operation, the light modulators 102 are designed such that when a range of intermediate voltages is applied through the data interconnects 112, there results a range of intermediate open states in the shutters 108 and therefore a range of inter-

mediate illumination states or luminance levels in the image **104**. In other cases, the data drivers **132** are configured to apply only a reduced set of 2, 3 or 4 digital voltage levels to the data interconnects **112**. These voltage levels are designed to set, in digital fashion, an open state, a closed state, or other discrete state to each of the shutters **108**.

The scan drivers **130** and the data drivers **132** are connected to a digital controller circuit **134** (also referred to as the “controller **134**”). The controller sends data to the data drivers **132** in a mostly serial fashion, organized in predetermined sequences grouped by rows and by image frames. The data drivers **132** can include series to parallel data converters, level shifting, and for some applications digital to analog voltage converters.

The display apparatus optionally includes a set of common drivers **138**, also referred to as common voltage sources. In some implementations, the common drivers **138** provide a DC common potential to all light modulators within the array of light modulators, for instance by supplying voltage to a series of common interconnects **114**. In some other implementations, the common drivers **138**, following commands from the controller **134**, issue voltage pulses or signals to the array of light modulators, for instance global actuation pulses which are capable of driving and/or initiating simultaneous actuation of all light modulators in multiple rows and columns of the array.

All of the drivers (e.g., scan drivers **130**, data drivers **132** and common drivers **138**) for different display functions are time-synchronized by the controller **134**. Timing commands from the controller coordinate the illumination of red, green and blue and white lamps (**140**, **142**, **144** and **146** respectively) via lamp drivers **148**, the write-enabling and sequencing of specific rows within the array of pixels, the output of voltages from the data drivers **132**, and the output of voltages that provide for light modulator actuation.

The controller **134** determines the sequencing or addressing scheme by which each of the shutters **108** can be re-set to the illumination levels appropriate to a new image **104**. New images **104** can be set at periodic intervals. For instance, for video displays, the color images **104** or frames of video are refreshed at frequencies ranging from 10 to 300 Hertz (Hz). In some implementations the setting of an image frame to the array is synchronized with the illumination of the lamps **140**, **142**, **144** and **146** such that alternate image frames are illuminated with an alternating series of colors, such as red, green, and blue. The image frames for each respective color is referred to as a color subframe. In this method, referred to as the field sequential color method, if the color subframes are alternated at frequencies in excess of 20 Hz, the human brain will average the alternating frame images into the perception of an image having a broad and continuous range of colors. In alternate implementations, four or more lamps with primary colors can be employed in display apparatus **100**, employing primaries other than red, green, and blue.

In some implementations, where the display apparatus **100** is designed for the digital switching of shutters **108** between open and closed states, the controller **134** forms an image by the method of time division gray scale, as previously described. In some other implementations, the display apparatus **100** can provide gray scale through the use of multiple shutters **108** per pixel.

In some implementations, the data for an image state **104** is loaded by the controller **134** to the modulator array by a sequential addressing of individual rows, also referred to as scan lines. For each row or scan line in the sequence, the scan driver **130** applies a write-enable voltage to the write enable interconnect **110** for that row of the array, and subsequently

the data driver **132** supplies data voltages, corresponding to desired shutter states, for each column in the selected row. This process repeats until data has been loaded for all rows in the array. In some implementations, the sequence of selected rows for data loading is linear, proceeding from top to bottom in the array. In some other implementations, the sequence of selected rows is pseudo-randomized, in order to minimize visual artifacts. And in some other implementations the sequencing is organized by blocks, where, for a block, the data for only a certain fraction of the image state **104** is loaded to the array, for instance by addressing only every 5<sup>th</sup> row of the array in sequence.

In some implementations, the process for loading image data to the array is separated in time from the process of actuating the shutters **108**. In these implementations, the modulator array may include data memory elements for each pixel in the array and the control matrix may include a global actuation interconnect for carrying trigger signals, from common driver **138**, to initiate simultaneous actuation of shutters **108** according to data stored in the memory elements.

In alternative implementations, the array of pixels and the control matrix that controls the pixels may be arranged in configurations other than rectangular rows and columns. For example, the pixels can be arranged in hexagonal arrays or curvilinear rows and columns. In general, as used herein, the term scan-line shall refer to any plurality of pixels that share a write-enabling interconnect.

The host processor **122** generally controls the operations of the host. For example, the host processor may be a general or special purpose processor for controlling a portable electronic device. With respect to the display apparatus **128**, included within the host device **120**, the host processor outputs image data as well as additional data about the host. Such information may include data from environmental sensors, such as ambient light or temperature; information about the host, including, for example, an operating mode of the host or the amount of power remaining in the host's power source; information about the content of the image data; information about the type of image data; and/or instructions for display apparatus for use in selecting an imaging mode.

The user input module **126** conveys the personal preferences of the user to the controller **134**, either directly, or via the host processor **122**. In some implementations, the user input module is controlled by software in which the user programs personal preferences such as “deeper color,” “better contrast,” “lower power,” “increased brightness,” “sports,” “live action,” or “animation.” In some other implementations, these preferences are input to the host using hardware, such as a switch or dial. The plurality of data inputs to the controller **134** direct the controller to provide data to the various drivers **130**, **132**, **138** and **148** which correspond to optimal imaging characteristics.

An environmental sensor module **124** also can be included as part of the host device. The environmental sensor module receives data about the ambient environment, such as temperature and or ambient lighting conditions. The sensor module **124** can be programmed to distinguish whether the device is operating in an indoor or office environment versus an outdoor environment in bright daylight versus and outdoor environment at nighttime. The sensor module communicates this information to the display controller **134**, so that the controller can optimize the viewing conditions in response to the ambient environment.

FIG. 2A shows a perspective view of an illustrative shutter-based light modulator **200**. The shutter-based light modulator is suitable for incorporation into the direct-view MEMS-based display apparatus **100** of FIG. 1A. The light modulator

200 includes a shutter 202 coupled to an actuator 204. The actuator 204 can be formed from two separate compliant electrode beam actuators 205 (the “actuators 205”). The shutter 202 couples on one side to the actuators 205. The actuators 205 move the shutter 202 transversely over a surface 203 in a plane of motion which is substantially parallel to the surface 203. The opposite side of the shutter 202 couples to a spring 207 which provides a restoring force opposing the forces exerted by the actuator 204.

Each actuator 205 includes a compliant load beam 206 connecting the shutter 202 to a load anchor 208. The load anchors 208 along with the compliant load beams 206 serve as mechanical supports, keeping the shutter 202 suspended proximate to the surface 203. The surface includes one or more aperture holes 211 for admitting the passage of light. The load anchors 208 physically connect the compliant load beams 206 and the shutter 202 to the surface 203 and electrically connect the load beams 206 to a bias voltage, in some instances, ground.

If the substrate is opaque, such as silicon, then aperture holes 211 are formed in the substrate by etching an array of holes through the substrate 204. If the substrate 204 is transparent, such as glass or plastic, then the aperture holes 211 are formed in a layer of light-blocking material deposited on the substrate 203. The aperture holes 211 can be generally circular, elliptical, polygonal, serpentine, or irregular in shape.

Each actuator 205 also includes a compliant drive beam 216 positioned adjacent to each load beam 206. The drive beams 216 couple at one end to a drive beam anchor 218 shared between the drive beams 216. The other end of each drive beam 216 is free to move. Each drive beam 216 is curved such that it is closest to the load beam 206 near the free end of the drive beam 216 and the anchored end of the load beam 206.

In operation, a display apparatus incorporating the light modulator 200 applies an electric potential to the drive beams 216 via the drive beam anchor 218. A second electric potential may be applied to the load beams 206. The resulting potential difference between the drive beams 216 and the load beams 206 pulls the free ends of the drive beams 216 towards the anchored ends of the load beams 206, and pulls the shutter ends of the load beams 206 toward the anchored ends of the drive beams 216, thereby driving the shutter 202 transversely towards the drive anchor 218. The compliant members 206 act as springs, such that when the voltage across the beams 206 and 216 potential is removed, the load beams 206 push the shutter 202 back into its initial position, releasing the stress stored in the load beams 206.

A light modulator, such as light modulator 200, incorporates a passive restoring force, such as a spring, for returning a shutter to its rest position after voltages have been removed. Other shutter assemblies can incorporate a dual set of “open” and “closed” actuators and a separate sets of “open” and “closed” electrodes for moving the shutter into either an open or a closed state.

There are a variety of methods by which an array of shutters and apertures can be controlled via a control matrix to produce images, in many cases moving images, with appropriate luminance levels. In some cases, control is accomplished by means of a passive matrix array of row and column interconnects connected to driver circuits on the periphery of the display. In other cases it is appropriate to include switching and/or data storage elements within each pixel of the array (the so-called active matrix) to improve the speed, the luminance level and/or the power dissipation performance of the display.

The display apparatus 100, in alternative implementations, includes light modulators other than transverse shutter-based light modulators, such as the shutter assembly 200 described above. For example, FIG. 2B shows a cross sectional view of a rolling actuator shutter-based light modulator 220. The rolling actuator shutter-based light modulator 220 is suitable for incorporation into an alternative implementation of the MEMS-based display apparatus 100 of FIG. 1A. A rolling actuator-based light modulator includes a movable electrode disposed opposite a fixed electrode and biased to move in a particular direction to function as a shutter upon application of an electric field. In some implementations, the light modulator 220 includes a planar electrode 226 disposed between a substrate 228 and an insulating layer 224 and a movable electrode 222 having a fixed end 230 attached to the insulating layer 224. In the absence of any applied voltage, a movable end 232 of the movable electrode 222 is free to roll towards the fixed end 230 to produce a rolled state. Application of a voltage between the electrodes 222 and 226 causes the movable electrode 222 to unroll and lie flat against the insulating layer 224, whereby it acts as a shutter that blocks light traveling through the substrate 228. The movable electrode 222 returns to the rolled state by means of an elastic restoring force after the voltage is removed. The bias towards a rolled state may be achieved by manufacturing the movable electrode 222 to include an anisotropic stress state.

FIG. 2C shows a cross sectional view of an illustrative non shutter-based MEMS light modulator 250. The light tap modulator 250 is suitable for incorporation into an alternative implementation of the MEMS-based display apparatus 100 of FIG. 1A. A light tap works according to a principle of frustrated total internal reflection (TIR). That is, light 252 is introduced into a light guide 254, in which, without interference, light 252 is, for the most part, unable to escape the light guide 254 through its front or rear surfaces due to TIR. The light tap 250 includes a tap element 256 that has a sufficiently high index of refraction that, in response to the tap element 256 contacting the light guide 254, the light 252 impinging on the surface of the light guide 254 adjacent the tap element 256 escapes the light guide 254 through the tap element 256 towards a viewer, thereby contributing to the formation of an image.

In some implementations, the tap element 256 is formed as part of a beam 258 of flexible, transparent material. Electrodes 260 coat portions of one side of the beam 258. Opposing electrodes 262 are disposed on the light guide 254. By applying a voltage across the electrodes 260 and 262, the position of the tap element 256 relative to the light guide 254 can be controlled to selectively extract light 252 from the light guide 254.

FIG. 2D shows an example cross sectional view of an electrowetting-based light modulation array 270. The electrowetting-based light modulation array 270 is suitable for incorporation into an alternative implementation of the MEMS-based display apparatus 100 of FIG. 1A. The light modulation array 270 includes a plurality of electrowetting-based light modulation cells 272a-d (generally “cells 272”) formed on an optical cavity 274. The light modulation array 270 also includes a set of color filters 276 corresponding to the cells 272.

Each cell 272 includes a layer of water (or other transparent conductive or polar fluid) 278, a layer of light absorbing oil 280, a transparent electrode 282 (made, for example, from indium-tin oxide (ITO) and an insulating layer 284 positioned between the layer of light absorbing oil 280 and the transparent electrode 282. In the implementation described herein, the electrode takes up a portion of a rear surface of a cell 272.

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The remainder of the rear surface of a cell **272** is formed from a reflective aperture layer **286** that forms the front surface of the optical cavity **274**. The reflective aperture layer **286** is formed from a reflective material, such as a reflective metal or a stack of thin films forming a dielectric mirror. For each cell **272**, an aperture is formed in the reflective aperture layer **286** to allow light to pass through. The electrode **282** for the cell is deposited in the aperture and over the material forming the reflective aperture layer **286**, separated by another dielectric layer.

The remainder of the optical cavity **274** includes a light guide **288** positioned proximate the reflective aperture layer **286**, and a second reflective layer **290** on a side of the light guide **288** opposite the reflective aperture layer **286**. A series of light redirectors **291** are formed on the rear surface of the light guide, proximate the second reflective layer. The light redirectors **291** may be either diffuse or specular reflectors. One or more light sources **292**, such as LEDs, inject light **294** into the light guide **288**.

In an alternative implementation, an additional transparent substrate (not shown) is positioned between the light guide **288** and the light modulation array **270**. In this implementation, the reflective aperture layer **286** is formed on the additional transparent substrate instead of on the surface of the light guide **288**.

In operation, application of a voltage to the electrode **282** of a cell (for example, cell **272b** or **272c**) causes the light absorbing oil **280** in the cell to collect in one portion of the cell **272**. As a result, the light absorbing oil **280** no longer obstructs the passage of light through the aperture formed in the reflective aperture layer **286** (see, for example, cells **272b** and **272c**). Light escaping the backlight at the aperture is then able to escape through the cell and through a corresponding color filter (for example, red, green or blue) in the set of color filters **276** to form a color pixel in an image. When the electrode **282** is grounded, the light absorbing oil **280** covers the aperture in the reflective aperture layer **286**, absorbing any light **294** attempting to pass through it.

The area under which oil **280** collects when a voltage is applied to the cell **272** constitutes wasted space in relation to forming an image. This area is non-transmissive, whether a voltage is applied or not. Therefore, without the inclusion of the reflective portions of reflective apertures layer **286**, this area absorbs light that otherwise could be used to contribute to the formation of an image. However, with the inclusion of the reflective aperture layer **286**, this light, which otherwise would have been absorbed, is reflected back into the light guide **290** for future escape through a different aperture. The electrowetting-based light modulation array **270** is not the only example of a non-shutter-based MEMS modulator suitable for inclusion in the display apparatus described herein. Other forms of non-shutter-based MEMS modulators could likewise be controlled by various ones of the controller functions described herein without departing from the scope of this disclosure.

FIG. 3A shows an example schematic diagram of a control matrix **300**. The control matrix **300** is suitable for controlling the light modulators incorporated into the MEMS-based display apparatus **100** of FIG. 1A. FIG. 3B shows a perspective view of an array **320** of shutter-based light modulators connected to the control matrix **300** of FIG. 3A. The control matrix **300** may address an array of pixels **320** (the "array **320**"). Each pixel **301** can include an elastic shutter assembly **302**, such as the shutter assembly **200** of FIG. 2A, controlled by an actuator **303**. Each pixel also can include an aperture layer **322** that includes apertures **324**.

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The control matrix **300** is fabricated as a diffused or thin-film-deposited electrical circuit on the surface of a substrate **304** on which the shutter assemblies **302** are formed. The control matrix **300** includes a scan-line interconnect **306** for each row of pixels **301** in the control matrix **300** and a data-interconnect **308** for each column of pixels **301** in the control matrix **300**. Each scan-line interconnect **306** electrically connects a write-enabling voltage source **307** to the pixels **301** in a corresponding row of pixels **301**. Each data interconnect **308** electrically connects a data voltage source **309** ("V<sub>d</sub> source") to the pixels **301** in a corresponding column of pixels. In the control matrix **300**, the V<sub>d</sub> source **309** provides the majority of the energy to be used for actuation of the shutter assemblies **302**. Thus, the data voltage source, V<sub>d</sub> source **309**, also serves as an actuation voltage source.

Referring to FIGS. 3A and 3B, for each pixel **301** or for each shutter assembly **302** in the array of pixels **320**, the control matrix **300** includes a transistor **310** and a capacitor **312**. The gate of each transistor **310** is electrically connected to the scan-line interconnect **306** of the row in the array **320** in which the pixel **301** is located. The source of each transistor **310** is electrically connected to its corresponding data interconnect **308**. The actuators **303** of each shutter assembly **302** include two electrodes. The drain of each transistor **310** is electrically connected in parallel to one electrode of the corresponding capacitor **312** and to one of the electrodes of the corresponding actuator **303**. The other electrode of the capacitor **312** and the other electrode of the actuator **303** in shutter assembly **302** are connected to a common or ground potential. In alternate implementations, the transistors **310** can be replaced with semiconductor diodes and or metal-insulator-metal sandwich type switching elements.

In operation, to form an image, the control matrix **300** write-enables each row in the array **320** in a sequence by applying V<sub>we</sub> to each scan-line interconnect **306** in turn. For a write-enabled row, the application of V<sub>we</sub> to the gates of the transistors **310** of the pixels **301** in the row allows the flow of current through the data interconnects **308** through the transistors **310** to apply a potential to the actuator **303** of the shutter assembly **302**. While the row is write-enabled, data voltages V<sub>d</sub> are selectively applied to the data interconnects **308**. In implementations providing analog gray scale, the data voltage applied to each data interconnect **308** is varied in relation to the desired brightness of the pixel **301** located at the intersection of the write-enabled scan-line interconnect **306** and the data interconnect **308**. In implementations providing digital control schemes, the data voltage is selected to be either a relatively low magnitude voltage (i.e., a voltage near ground) or to meet or exceed V<sub>at</sub> (the actuation threshold voltage). In response to the application of V<sub>at</sub> to a data interconnect **308**, the actuator **303** in the corresponding shutter assembly actuates, opening the shutter in that shutter assembly **302**. The voltage applied to the data interconnect **308** remains stored in the capacitor **312** of the pixel **301** even after the control matrix **300** ceases to apply V<sub>we</sub> to a row. Therefore, the voltage V<sub>we</sub> does not have to wait and hold on a row for times long enough for the shutter assembly **302** to actuate; such actuation can proceed after the write-enabling voltage has been removed from the row. The capacitors **312** also function as memory elements within the array **320**, storing actuation instructions for the illumination of an image frame.

The pixels **301** as well as the control matrix **300** of the array **320** are formed on a substrate **304**. The array includes an aperture layer **322**, disposed on the substrate **304**, which includes a set of apertures **324** for respective pixels **301** in the array **320**. The apertures **324** are aligned with the shutter assemblies **302** in each pixel. In some implementations, the

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substrate **304** is made of a transparent material, such as glass or plastic. In some other implementations, the substrate **304** is made of an opaque material, but in which holes are etched to form the apertures **324**.

The shutter assembly **302** together with the actuator **303** can be made bi-stable. That is, the shutters can exist in at least two equilibrium positions (e.g., open or closed) with little or no power required to hold them in either position. More particularly, the shutter assembly **302** can be mechanically bi-stable. Once the shutter of the shutter assembly **302** is set in position, no electrical energy or holding voltage is required to maintain that position. The mechanical stresses on the physical elements of the shutter assembly **302** can hold the shutter in place.

The shutter assembly **302** together with the actuator **303** also can be made electrically bi-stable. In an electrically bi-stable shutter assembly, there exists a range of voltages below the actuation voltage of the shutter assembly, which if applied to a closed actuator (with the shutter being either open or closed), holds the actuator closed and the shutter in position, even if an opposing force is exerted on the shutter. The opposing force may be exerted by a spring such as spring **207** in the shutter-based light modulator **200** depicted in FIG. 2A, or the opposing force may be exerted by an opposing actuator, such as an "open" or "closed" actuator.

The light modulator array **320** is depicted as having a single MEMS light modulator per pixel. Other implementations are possible in which multiple MEMS light modulators are provided in each pixel, thereby providing the possibility of more than just binary "on" or "off" optical states in each pixel. Certain forms of coded area division gray scale are possible where multiple MEMS light modulators in the pixel are provided, and where apertures **324**, which are associated with each of the light modulators, have unequal areas.

In some other implementations, the roller-based light modulator **220**, the light tap **250**, or the electrowetting-based light modulation array **270**, as well as other MEMS-based light modulators, can be substituted for the shutter assembly **302** within the light modulator array **320**.

FIGS. 4A and 4B show example views of a dual actuator shutter assembly **400**. The dual actuator shutter assembly, as depicted in FIG. 4A, is in an open state. FIG. 4B shows the dual actuator shutter assembly **400** in a closed state. In contrast to the shutter assembly **200**, the shutter assembly **400** includes actuators **402** and **404** on either side of a shutter **406**. Each actuator **402** and **404** is independently controlled. A first actuator, a shutter-open actuator **402**, serves to open the shutter **406**. A second opposing actuator, the shutter-close actuator **404**, serves to close the shutter **406**. Both of the actuators **402** and **404** are compliant beam electrode actuators. The actuators **402** and **404** open and close the shutter **406** by driving the shutter **406** substantially in a plane parallel to an aperture layer **407** over which the shutter is suspended. The shutter **406** is suspended a short distance over the aperture layer **407** by anchors **408** attached to the actuators **402** and **404**. The inclusion of supports attached to both ends of the shutter **406** along its axis of movement reduces out of plane motion of the shutter **406** and confines the motion substantially to a plane parallel to the substrate. As will be described below, a variety of different control matrices may be used with the shutter assembly **400**.

The shutter **406** includes two shutter apertures **412** through which light can pass. The aperture layer **407** includes a set of three apertures **409**. In FIG. 4A, the shutter assembly **400** is in the open state and, as such, the shutter-open actuator **402** has been actuated, the shutter-close actuator **404** is in its relaxed position, and the centerlines of the shutter apertures **412**

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coincide with the centerlines of two of the aperture layer apertures **409**. In FIG. 4B, the shutter assembly **400** has been moved to the closed state and, as such, the shutter-open actuator **402** is in its relaxed position, the shutter-close actuator **404** has been actuated, and the light blocking portions of shutter **406** are now in position to block transmission of light through the apertures **409** (depicted as dotted lines).

Each aperture has at least one edge around its periphery. For example, the rectangular apertures **409** have four edges. In alternative implementations in which circular, elliptical, oval, or other curved apertures are formed in the aperture layer **407**, each aperture may have only a single edge. In some other implementations, the apertures need not be separated or disjoint in the mathematical sense, but instead can be connected. That is to say, while portions or shaped sections of the aperture may maintain a correspondence to each shutter, several of these sections may be connected such that a single continuous perimeter of the aperture is shared by multiple shutters.

In order to allow light with a variety of exit angles to pass through apertures **412** and **409** in the open state, it is advantageous to provide a width or size for shutter apertures **412** which is larger than a corresponding width or size of apertures **409** in the aperture layer **407**. In order to effectively block light from escaping in the closed state, it is preferable that the light blocking portions of the shutter **406** overlap the apertures **409**. FIG. 4B shows a predefined overlap **416** between the edge of light blocking portions in the shutter **406** and one edge of the aperture **409** formed in aperture layer **407**.

The electrostatic actuators **402** and **404** are designed so that their voltage-displacement behavior provides a bi-stable characteristic to the shutter assembly **400**. For each of the shutter-open and shutter-close actuators, there exists a range of voltages below the actuation voltage, which if applied while that actuator is in the closed state (with the shutter being either open or closed), will hold the actuator closed and the shutter in position, even after an actuation voltage is applied to the opposing actuator. The minimum voltage needed to maintain a shutter's position against such an opposing force is referred to as a maintenance voltage  $V_m$ .

In certain display apparatus, it is desirable for display apparatus having MEMS light modulators to actuate the MEMS devices, such as shutters, at increased speeds with reduced power consumption. One way to achieve this goal is to electrostatically actuate a shutter with a voltage source rather than with a stored charge on some "pre-charged" node.

With a pre-charged node not coupled to a powered voltage source during actuation, the charge that attracts the shutter is constant. As such, as the shutter engages, the capacitance  $C$  between the beams that form the actuator increases and the voltage  $V$  between the shutter and the charged actuation node decreases in accordance with the fundamental relationship:

$$Q = C * V$$

That is, the voltage difference between the actuator and shutter goes down proportionally to the increase in capacitance and the actuating force is reduced by, approximately the proportion of the square of the voltage change according to relationship:

$$\text{Force of actuation} = K * V^2 / d^2$$

where  $K$  is a spring constant.

Since the force is inversely proportional to the distance "d" between the actuator and the shutter, it turns out that the attractive force with charge actuation remains constant assuming that the capacitance is directly proportional to the distance "d." In some implementations, a constant force is



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sufficient, but as the shutter engages an actuator, the shutter is typically working against a spring that produces more opposing force as the shutter is engaged. In addition, the shutter experiences a resistive force caused by squeeze film damping of fluid being forced out from between the actuator/shutter closing interface. This tends to slow down the shutter transition time and reduce the efficiency and visual quality of the display. Accordingly, to counter the increasing spring force and squeeze film damping, an actuation force that increases through the actuation stroke can be provided. In some implementations, this can be achieved by actively coupling the actuator to a voltage source that can apply a constant voltage across the actuator throughout the actuation stroke, even as the capacitance of the actuator increases.

FIG. 5 shows a portion of an example control matrix 500. The control matrix 500 can be implemented for use in the display apparatus 100 depicted in FIG. 1. The structure of the control matrix 500 is described immediately below. Its operation will be described thereafter with respect to FIG. 6.

The control matrix 500 controls an array of pixels 502 that includes MEMS-based light modulators. In some implementations, the MEMS-based light modulators may be shutter-based light modulators that include at least one shutter assembly, such as the shutter assembly 200 depicted in FIG. 2A.

The control matrix 500 includes a scan-line interconnect 506 for each row of pixels 502 in the display apparatus 100 and a data interconnect 508 for each column of pixels 502. The scan-line interconnect 506 is configured to allow data to be loaded onto the pixel 502. The data interconnect 508 is configured to provide a data voltage corresponding to the data to be loaded on to the pixel 502. Further, the control matrix 500 includes a pre-charge interconnect 510, an actuation voltage interconnect 520, a global update interconnect 532 and a common drain interconnect 534 (collectively referred to as "common interconnects"). These common interconnects 510, 520, 532 and 534 are shared among pixels 502 in multiple rows and multiple columns in the array. In some implementations, the common interconnects 510, 520, 532 and 534 are shared among all pixels 502 in the display apparatus 100.

Each pixel 502 in the control matrix 500 also includes a write-enable transistor 552 and a data store capacitor 554. The gate of the write-enable transistor 552 is coupled to the scan-line interconnect 506 such that the scan-line interconnect 506 controls the write-enable transistor 552. The source of the write-enable transistor 552 is coupled to the data interconnect 508 and the drain of the write-enable transistor 552 is coupled to a first terminal of the data store capacitor 554. A second terminal of the data store capacitor 554 is coupled to the common drain interconnect 534. In this way, as the write-enable transistor 552 is switched on via a write-enabling voltage provided by the scan-line interconnect 506, a data voltage provided by the data interconnect 508 passes through the write-enable transistor 552 and is stored at the data store capacitor 554. The stored data voltage is then used to drive the pixel 502 to one of a first pixel state or second pixel state.

Each pixel 502 in the control matrix 500 also includes a pre-charge trigger transistor 512 and a pre-charge discharge transistor 514. The pre-charge trigger transistor 512 and the pre-charge discharge transistor 514 govern the application and storage of a pre-charge signal. The gate and drain of the pre-charge trigger transistor 512 are coupled to the pre-charge interconnect 510, while the source of the pre-charge trigger transistor 512 is coupled to the drain of the pre-charge discharge transistor 514 at a pre-charge node 516. The gate of the pre-charge discharge transistor 514 is coupled to the data store capacitor 554 and the drain of the write-enabling transistor 552. The source of the pre-charge discharge transistor

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514 is coupled to the global update interconnect 532. Details of the functionality of the pre-charge trigger transistor 512 and the pre-charge discharge transistor 514 will become apparent below with respect to FIG. 6.

Each pixel 502 of the control matrix 500 also includes a source follower circuit 525 that includes an actuation voltage transistor 522 and an actuation discharge transistor 524. The actuation voltage transistor 522 and the actuation discharge transistor 524 govern the application of an actuation voltage provided by the actuation voltage interconnect 520, which serves as a voltage source. The gate of the actuation voltage transistor 522 is coupled to the pre-charge node 516 and the drain of the actuation voltage transistor 522 is coupled to the actuation voltage interconnect 520. The gate of the actuation discharge transistor 524 is coupled to the data store capacitor 554 and the gate of the pre-charge discharge transistor 514. The source of the actuation discharge transistor 524 is coupled to the global update interconnect 532. The drain of the actuation discharge transistor 524 is coupled to the source of the actuation voltage transistor 522 at an actuation node 526. The actuation node 526 is coupled to an actuator of a light modulator of the pixel 502 that drives the pixel to one of the first pixel state and the second pixel state.

In some implementations, each of the write enabling transistor 552, the pre-charge trigger transistor 512, the pre-charge discharge transistor 514, the actuation voltage transistor 522 and the actuation discharge transistor 524 are either all n-type transistors or all p-type transistors. In some implementations, the control matrix 500 is designed with transistors all of n-type transistors. Alternatively, the circuit could be designed with all p-type transistors. Circuits formed from only one-type of transistors are particularly useful in more recent Indium Gallium Zinc Oxide (IGZO) manufacturing processes, especially where p-type transistors are difficult to build.

FIG. 6 shows a flow diagram of an example frame addressing and pixel actuation method 600. The method 600 may be employed, for example, to operate the control matrix 500 of FIG. 5. The frame addressing and pixel actuation method 600 proceeds in four general stages. First, various interconnects of the control matrix are pre-loaded with voltages (block 642). Next, data voltages for pixels in a display are loaded for each pixel one row at a time in a data loading stage (block 644). Next, in a precharging stage, a pre-charge node for each pixel is pre-charged (block 646). Upon pre-charging the pre-charge actuation node for each pixel, the pixels are actuated in an actuation stage (block 648). Although the frame addressing and pixel actuation method 600 is described in detail with respect to FIG. 5, some or all of the operations of the method 600 are employed to operate other control matrix implementations, such as the control matrix 800 depicted in FIG. 8. Furthermore, in some control matrix implementations, such as the control matrix 800, the light modulator actuation stage (block 648) may be performed differently than as described here with respect to the control matrix 500 depicted in FIG. 5. Such differences will be described below with respect to the description of the control matrix 800.

Details of the various stages of the frame addressing and pixel actuation method 600 will be described with reference to a timing diagram depicted in FIG. 7. FIG. 7 shows a timing diagram 700 of example voltages applied to various interconnects of a control matrix. The timing diagram 700 may be employed, for example, to operate the control matrix 500 of FIG. 5 according to the frame addressing and pixel actuation method 600 depicted in FIG. 6.

In particular, the timing diagram 700 includes separate timing graphs indicating the voltages at various nodes and



interconnects during the various stages of the frame addressing and pixel actuation method 600 employed by the control matrix 500. The timing diagram includes a timing graph 702 indicating the voltage applied to the pre-charge interconnect 510, a timing graph 704 indicating the voltage applied to the global update interconnect 532, a timing graph 706 indicating the voltage applied to the actuation voltage interconnect 520, a timing graph 708 indicating the voltage applied to the data interconnect 508, a timing graph 710 indicating the voltage applied to the scan-line interconnect 506 and a timing graph 712 indicating the voltage at the actuation node 526.

Further, the timing diagram 700 is separated into a first region corresponding to a first pixel state and a second region corresponding to a second pixel state. Both the first and second regions include portions corresponding to the various stages of the frame addressing and pixel actuation method 600. Each of the first and second regions include corresponding pre-load portions 742a-b that correspond to the pre-loading stage, data loading portions 744a-b that correspond to the data loading stage, pre-charge portions 746a-b that correspond to the pre-charge actuation node stage and actuation portions 748a-b that correspond to the light modulator actuation stage. It should be appreciated that the timing diagram is not drawn to scale and that the relative lengths and widths of each of the timing graphs are not intended to indicate particular voltages or durations of time.

Referring now to the frame addressing and pixel actuation method 600 depicted in FIG. 6 with references being made to the control matrix 500 depicted in FIG. 5 and the timing diagram 700 depicted in FIG. 7, the pre-loading stage (block 642) corresponds to the pre-load portions 742a-b of the timing diagram 700. The pre-loading stage proceeds with maintaining an actuation voltage at the actuation voltage interconnect 520 (block 650). The actuation voltage may be a voltage that is sufficient to actuate the actuator of the pixel causing the pixel to assume either one of a first pixel state or a second pixel state. As depicted in the timing graph 706, the actuation voltage interconnect 520 is maintained at an actuation voltage, for example, about 10-40V. In some implementations, the actuation voltage may be even lower than 10V. The pre-loading stage also includes applying a holding voltage to the global update interconnect (block 652). The holding voltage applied to the global update interconnect can be sufficiently high to prevent activation of the pre-charge discharge transistor 514 until all rows have been addressed. This is depicted in the pre-load portions 742a-b of the timing graph 704.

After the pre-loading stage (block 642), the data loading stage (block 644) for addressing each of the pixels of a particular row of the array begins. The data loading portions 744a-b of the timing diagram 700 correspond to the data loading stage (block 644). Based on if the future pixel state received by the control matrix is a first pixel state, such as an ON state, or a second pixel state, such as an OFF state, (decision block 660), the control matrix proceeds with either loading an ON voltage to the pixel 502 (blocks 662, 663 and 664) or loading an OFF voltage to the pixel 502 (blocks 666, 667 and 668).

If the pixel 502 is to assume the ON state, the control matrix 500 applies an ON state voltage to the data interconnect 508 (block 662). In some implementations, the control matrix 500 loads the ON voltage by applying a data voltage  $V_d$ , for example about 3-5V, to the data interconnect 508 corresponding to the column in which that pixel 502 is located. This is depicted in the data loading portion 744a of the timing graph 708.

The control matrix then applies a write-enabling voltage  $V_{we}$  to a scan-line interconnect corresponding to the row of

the array of pixels (block 663). This is also depicted in the data loading portions 744a of the timing graph 710. The application of the write-enabling voltage  $V_{we}$ , again about 3-5V, to the scan-line interconnect 506 for the write-enabled row turns on the write-enable transistors, such as write-enable transistor 552, of all pixels in the row. In this way, the data voltage  $V_d$  applied to the data interconnect 508 is caused to be stored as a charge on the data store capacitor 554 of the selected pixel 502 (block 664). That is, because the write-enable transistor 552 is switched on for at least a portion of the time the data voltage  $V_d$  is applied to the data interconnect 508, the data voltage  $V_d$  passes through the write-enable transistor 552 to the data store capacitor 554 on which it is stored as a charge.

If the pixel 502 is to assume the OFF state, the control matrix 500 loads an OFF voltage on to the data interconnect 508 (block 666). In some implementations, the control matrix 500 loads the OFF voltage by grounding the data interconnect 508 corresponding to the column in which that pixel 502 is located. In some implementations, since the data interconnect 508 is grounded, there is no data voltage  $V_d$  and therefore, no charge can be stored on the data store capacitor 554. This is depicted by the data loading portion 744B of the timing graph 708.

The control matrix 500 applies the write-enabling voltage  $V_{we}$  to the scan-line interconnect 506 corresponding to the row (block 667) such that the scan-line interconnect 506 is write-enabled. This is depicted in the data loading portion 744B of the timing graph 710. In this way, the OFF voltage applied to the data interconnect 508 is caused to be stored as a charge on the data store capacitor 554 of the selected pixel 502 (block 668). In some implementations, since the data interconnect 508 is grounded, there is no data voltage  $V_d$  and therefore, no charge is stored on the data store capacitor 554.

The process of loading data can be performed simultaneously in each of the pixels in the row that is write-enabled. In this way, the control matrix 500 selectively applies the data voltage to columns of a given row in the control matrix 500 at the same time prior to that row being write-enabled. In some implementations, the control matrix 500 only applies the data voltage to those columns whose pixels are to be actuated towards the first pixel state. Once all the pixels in the row are addressed, the control matrix 500 removes the write-enabling voltage  $V_{we}$  from the scan-line interconnect 506 (block 670). Depending on whether the data voltage corresponds to an ON state or an OFF state, removing the voltage from the scan-line interconnect 506 is depicted in the data loading portion 744a-b of the timing graph 710. In some implementations, the control matrix 500 grounds the scan-line interconnect 506. The data loading stage (block 644) is then repeated for subsequent rows of the array in the control matrix 500. At the end of the data loading stage (block 644), each of the data store capacitors in the selected group of pixels contains the data voltage which is appropriate for the setting of the next image state.

The control matrix 500 then proceeds with the precharging stage (block 646) where a voltage sufficient to initiate actuation is stored on the actuator in response to a pre-charge voltage being applied to the pre-charge trigger transistor 512. The pre-charging portion 746a-b of the timing diagram 700 correspond to the pre-charge actuator stage (block 646). The pre-charge actuator stage (block 646) begins by applying a pre-charge voltage to the pre-charge interconnect 510 (block 672). This is depicted in the pre-charging state 746a-b of the timing graph 702. In some implementations, the pre-charge voltage may be a voltage that is sufficient to switch on the pre-charge trigger transistor 512, for example, about 3-5V. In

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response to the pre-charge trigger transistor **512** turning on, the pre-charge node **516** assumes a high voltage state since a path between the pre-charge interconnect **510** and the pre-charge node **516** is opened. In response to the pre-charge node **516** assuming a high voltage state, the actuation voltage transistor **522** switches on, creating an active path between the actuation voltage interconnect **520** and the actuator of the light modulator. As a result, the voltage at the actuation node **526** becomes high. This is depicted in the pre-charging portion **746a** of the timing graph **712**, which corresponds to the voltage at the actuation node **526**.

This path remains open until the voltage being applied to the gate of the actuation voltage transistor **522** is removed. In some implementations, the voltage being applied to the gate of the actuation voltage transistor **522** is removed by draining the voltage via the pre-charge discharge transistor **514**. At a time after the actuation node **526** is brought to the actuation voltage and prior to draining the voltage applied to the gate of the actuation voltage transistor **522**, the pre-charge voltage applied to the pre-charge interconnect **510** is removed (block **674**). This is also depicted in the pre-charging portion **746a** of the timing graph **702**. In some implementations, the pre-charge interconnect **510** is grounded to remove the pre-charge voltage.

Once the actuator of the light modulator is brought to the actuation voltage, the control matrix **500** then proceeds with the actuation stage (block **648**). The actuation portions **748a-b** of the timing diagram **700** correspond to the actuation stage (block **648**). The actuation stage proceeds with deactivating the global update interconnect **532** (block **678**). This is depicted in the actuation portions **748a-b** of the timing graph **704**. In some implementations, the global update interconnect **532** is deactivated by grounding the global update interconnect **532**. Upon deactivating the global update interconnect **532**, various operations take place.

First, depending on the data voltage stored on the data store capacitor **554**, the pre-charge discharge transistor **514** either switches on or remains switched off. If the data voltage stored on the data store capacitor **554** is a high voltage, the pre-charge discharge transistor **514** switches on, thereby draining the pre-charge voltage stored on the pre-charge node **516** and thereby switching the actuation voltage transistor **522** off. If the data voltage stored on the data store capacitor **554** is a low voltage, the pre-charge discharge transistor **514** remains off, thereby leaving the actuation voltage transistor **522** switched on.

Second, similar to the operation of the pre-charge discharge transistor **514**, the actuation discharge transistor **524** also either switches on or remains off based on the data voltage stored on the data store capacitor **554**, such that if the pre-charge discharge transistor **514** switches on, the actuation discharge transistor **524** also switches on. Conversely, if the pre-charge discharge transistor **514** remains switched off, the actuation discharge transistor **524** also remains switched off.

If the data voltage stored on the data store capacitor **554** is a high voltage, the pre-charge discharge transistor **514** and the actuation discharge transistor **524** are switched on. This causes the actuation voltage transistor **522** to switch off and causes the actuation voltage at the actuation node **526** to drain through the actuation discharge transistor **524**. This is depicted in the actuation portion **748a** of the timing graph **712**. As a result, the actuator of the light modulator does not actuate. However, if the data voltage stored on the data store capacitor **554** is a low voltage, the pre-charge discharge transistor **514** and the actuation discharge transistor **524** remain off. This causes the actuation voltage transistor **522** to remain on. This is depicted in the actuation portion **748b** of the timing

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graph **712**. By causing the actuation voltage transistor **522** to remain on, the actuation voltage supplied by the actuation voltage interconnect **520** is applied to the actuator of the light modulator at the actuation node **526**. This causes the actuator to actuate, while providing an actuation voltage throughout the actuation stroke of the actuator. Since the actuator is connected to the actuation voltage interconnect **520**, the actuation voltage interconnect **520** can provide a constant actuation voltage to the actuator as the force to move the light modulator towards the actuator increases.

FIG. **8** shows a portion of another example control matrix **800**. The control matrix **800** can be implemented for use in the display apparatus **100** depicted in FIG. **1**. The control matrix **800** controls an array of pixels **802** that includes MEMS-based light modulators. In some implementations, the MEMS-based light modulators may be shutter-based light modulators that include at least one shutter assembly, such as the shutter assembly **200** depicted in FIG. **2A**. The control matrix **800** may be configured for use with dual-actuator light modulators, such as the dual actuator shutter assembly **400** depicted in FIG. **4**.

The control matrix **800** includes a scan-line interconnect **806** for each row of pixels **802** in the display apparatus **100** and a data interconnect **808** for each column of pixels **802**. The scan-line interconnect **806** is configured to allow data to be loaded onto the pixel **802**. The data interconnect **808** is configured to provide a data voltage corresponding to the data to be loaded on to the pixel **802**. Further, the control matrix **800** includes a pre-charge interconnect **810**, an actuation voltage interconnect **820**, a first global update interconnect **832**, a second global update interconnect **833** and a common drain interconnect **834** (collectively referred to as "common interconnects"). These common interconnects **810**, **820**, **832**, **833** and **834** are shared among pixels **802** in multiple rows and multiple columns in the array. In some implementations, the common interconnects **810**, **820**, **832**, **833** and **834** are shared among all pixels **802** in the display apparatus **100**.

Each pixel **802** in the control matrix **800** also includes a write-enable transistor **852** and a data store capacitor **854**. The gate of the write-enable transistor **852** is coupled to the scan-line interconnect **806** such that the scan-line interconnect **806** controls the write-enable transistor **852**. The source of the write-enable transistor **852** is coupled to the data interconnect **808** and the drain of the write-enable transistor **852** is coupled to a first terminal of the data store capacitor **854**. A second terminal of the data store capacitor **854** is coupled to the common drain interconnect **834**. In this way, as the write-enable transistor **852** is switched on via a write-enabling voltage provided by the scan-line interconnect **806**, a data voltage provided by the data interconnect **808** passes through the write-enable transistor **852** and is stored at the data store capacitor **854**. The stored data voltage is then used to drive the pixel **802** to one of a first pixel state or a second pixel state.

Each pixel **802** in the control matrix **800** also includes a first pre-charge trigger transistor **812** and a first pre-charge discharge transistor **814**. The first pre-charge trigger transistor **812** and the first pre-charge discharge transistor **814** govern the application and storage of a first pre-charge signal. The source of the first pre-charge trigger transistor **812** is coupled to the actuation voltage interconnect **820**. The gate of the first pre-charge trigger transistor **812** is coupled to the pre-charge interconnect **810**, while the source of the first pre-charge trigger transistor **812** is coupled to the drain of the first pre-charge discharge transistor **814** at a first pre-charge node **816**. The gate of the first pre-charge discharge transistor **814** is coupled to the data store capacitor **854** and the drain of

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the write-enabling transistor **852**. The source of the first pre-charge discharge transistor **814** is coupled to the first global update interconnect **832**.

Each pixel **802** of the control matrix **800** also includes a first actuation voltage transistor **822** and a first actuation discharge transistor **824**. The first actuation voltage transistor **822** and the first actuation discharge transistor **824** govern the application of an actuation voltage provided by the actuation voltage interconnect **820** to the first actuator. In this way, the actuation voltage interconnect **820** serves as a voltage source to the first actuator. The gate of the first actuation voltage transistor **822** is coupled to the first pre-charge node **816** and the drain of the first actuation voltage transistor **822** is coupled to the actuation voltage interconnect **820**. The gate of the first actuation discharge transistor **824** is coupled to the data store capacitor **854** and the gate of the first pre-charge discharge transistor **814**. The source of the first actuation discharge transistor **824** is coupled to the first global update interconnect **832**. The drain of the first actuation discharge transistor **824** is coupled to the source of the first actuation voltage transistor **822** at a first actuation node **826**. The first actuation node **826** is coupled to a first actuator of the pixel **802** that is configured to drive the pixel to a first pixel state.

In addition, each pixel **802** of the control matrix **800** also includes a second charge trigger transistor **862** and a second pre-charge discharge transistor **864**. The second pre-charge trigger transistor **862** and the second pre-charge discharge transistor **864** govern the application and storage of a second pre-charge signal. The gate of the second pre-charge trigger transistor **862** is coupled to the pre-charge interconnect **810**. The source of the second pre-charge trigger transistor **862** is coupled to the first pre-charge node **816**, while the drain of the second pre-charge trigger transistor **862** is coupled to the drain of the second pre-charge discharge transistor **864** at a second pre-charge node **866**. The gate of the second pre-charge discharge transistor **864** is coupled to the drain of the first actuation discharge transistor **824**. The source of the second pre-charge discharge transistor **864** is coupled to the second global update interconnect **833**.

Each pixel **802** of the control matrix **800** also includes a second actuation voltage transistor **872** and a second actuation discharge transistor **874**. The second actuation voltage transistor **872** and the second actuation discharge transistor **874** govern the application of an actuation voltage provided by the actuation voltage interconnect **820** to the second actuator. In this way, the actuation voltage interconnect **820** serves as a voltage source to the second actuator. The gate of the second actuation voltage transistor **872** is coupled to the second pre-charge node **866** and the drain of the second actuation voltage transistor **872** is coupled to the actuation voltage interconnect **820**. The gate of the second actuation discharge transistor **874** is coupled to the drain of the first actuation discharge transistor **824**. The source of the second actuation discharge transistor **874** is coupled to the source of the second actuation voltage transistor **872** at a second actuation node **876**. The second actuation node **876** is coupled to a second actuator of the pixel **802** that is configured to drive the pixel to the second pixel state.

In some implementations, each of the write enabling transistor **852**, the first pre-charge trigger transistor **812**, the first pre-charge discharge transistor **814**, the first actuation voltage transistor **822**, the first actuation discharge transistor **824**, the second pre-charge trigger transistor **862**, the second pre-charge discharge transistor **864**, the second actuation voltage transistor **872** and the second actuation discharge transistor

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**874** are all either n-type transistors or p-type transistors. In some implementations, the control matrix **800** is designed with transistors all of n-type transistors. Alternatively, the circuit could be designed with all p-type transistors. Circuits formed from only one-type of transistors are particularly useful in more recent Indium Gallium Zinc Oxide (IGZO) manufacturing processes, especially where p-type transistors are difficult to build.

The control matrix **800** operates in a manner substantially similar to the control matrix **500** depicted in FIG. 5. Generally, the control matrix **800** performs a frame addressing and pixel actuation method similar to the frame addressing and pixel actuation method **600** described with respect to FIG. 6. The frame addressing and pixel actuation method utilized for the controlling the control matrix **800** proceeds in four general stages. First, various interconnects of the control matrix **800** are pre-loaded with voltages. Next, data voltages for pixels in a display are loaded for each pixel one row at a time in a data loading stage. Next, in a pre-charge actuator stage, a pre-charge node for each pixel is pre-charged. Upon pre-charging the pre-charge actuation node for each pixel, the pixels are actuated in an actuation stage.

Unlike the control matrix **500** depicted in FIG. 5, the control matrix **800** includes two global update interconnects. Accordingly, during the pre-loading stage, both the first global update interconnect **832** and the second global update interconnect **833** are activated. The control matrix **800** performs the data loading stage and the pre-charge actuation node stage in a manner substantially similar to the control matrix **500**. However, during the actuation stage, in contrast to the control matrix **500**, the control matrix **800** deactivates one of the first global update interconnect **832** and the second global update interconnect **833** prior to deactivating the other of the first global update interconnect **832** and the second global update interconnect **833**. Additional details of the operation of the control matrix **800** will be described using a timing diagram depicted in FIG. 9.

FIG. 9 shows a timing diagram **900** of example voltages applied to various interconnects of a control matrix. The timing diagram **900** may be employed, for example, to operate the control matrix **800** of FIG. 8 according to the frame addressing and pixel actuation method that is substantially similar to the frame addressing and pixel actuation method **600** depicted in FIG. 6. In particular, the timing diagram **900** includes separate timing graphs indicating the voltages at various nodes and interconnects during the various stages of the frame addressing and pixel actuation method employed by the control matrix **800**.

The timing diagram **900** includes a timing graph **902** indicating the voltage applied to the pre-charge interconnect **810**, a timing graph **904** indicating the voltage applied to the first global update interconnect **832**, a timing graph **905** indicating the voltage applied to the second global update interconnect **833**, a timing graph **906** indicating the voltage applied to the actuation voltage interconnect **820**, a timing graph **908** indicating the voltage applied to the data interconnect **808**, a timing graph **910** indicating the voltage applied to the scanline interconnect **806**, a timing graph **912** indicating the voltage at the first actuation node **826** and a timing graph **913** indicating the voltage at the second actuation node **876**.

Further, the timing diagram **900** is separated into a first region corresponding to a first pixel state and a second region corresponding to a second pixel state. Both the first and second regions include portions corresponding to the various stages of the frame addressing and pixel actuation method used to operate the control matrix **800**. Each of the first and second regions include corresponding pre-load portions

**942a-b** that correspond to the pre-loading stage, data loading portions **944a-b** that correspond to the data loading stage, pre-charge portions **946a-b** that correspond to the pre-charge actuation node stage and actuation portions **948a-b** that correspond to the light modulator actuation stage. It should be appreciated that the timing diagram is not drawn to scale and that the relative lengths and widths of each of the timing graphs are not intended to indicate particular voltages or durations of time.

In operation, the control matrix **800** begins with the pre-loading stage depicted by the pre-load portions **942a-b**. The actuation voltage remains applied to the actuation voltage interconnect **820** and a holding voltage is applied to the first global update interconnect **832** and the second global update interconnect **833**. In some implementations, the first global update interconnect **832** and the second global update interconnect **833** are activated simultaneously by applying a holding voltage. During this stage, the voltage at the first actuation node **826** and the second actuation node **876** depends on the previous state of the pixel.

The control matrix **800** then proceeds to the data loading stage depicted by the data loading portions **944a-b**. In this portion, a data voltage corresponding to the next pixel state that the pixel will assume is applied to the data interconnect **808**. The data voltage may either be high or low. The data loading portion **944a** depicts the data loading stage if the data voltage is high, while the data loading portion **944b** depicts the data loading stage if the data voltage is low. A write-enabling voltage is then applied to the scan-line interconnect **806** that causes the write-enabling transistor **852** to switch on. As a result, the data voltage applied to the data interconnect **808** is stored at the data store capacitor **854**. Once the data voltage corresponding to the next pixel state is stored on the data store capacitor **854**, the control matrix **800** proceeds to the pre-charge actuation node stage.

In the pre-charge actuation node stage, the control matrix **800** applies a pre-charge voltage to the pre-charge interconnect **810**. As a result, the first pre-charge trigger transistor **812** is switched on and the pre-charge voltage passes through to the first pre-charge node **816**. The first pre-charge node **816** is coupled to the gate of the first actuation voltage transistor **822**, and therefore, the first actuation voltage transistor **822** is responsive to the voltage at the first pre-charge node **816**. As a result, the first actuation voltage transistor **822** is switched on. This allows the actuation voltage maintained at the actuation voltage interconnect **820** to pass through the first actuation voltage transistor **822** to the first actuation node **826** depicted by the timing graph **912**. In this way, the first actuation node **826** is pre-charged with the actuation voltage.

At about the same time that the first pre-charge trigger transistor **812** is switched on, the second pre-charge trigger transistor **862** is also switched on. Since the first pre-charge node **816** is coupled to the source of the second pre-charge trigger transistor **862**, the second pre-charge node **862** also achieves the pre-charge voltage. This in turn actuates the second actuation voltage transistor **872** that allows the actuation voltage from the actuation voltage interconnect **820** to pass through to the second actuation node **876** depicted by the timing graph **913**. In this way, the second actuation node **876** is pre-charged with the actuation voltage. Once the first actuation node **826** and the second actuation node **876** assume the actuation voltage, the pre-charge voltage applied to the pre-charge interconnect **810** is removed.

The control matrix **800** then proceeds with the light modulator actuation stage. This stage is depicted by the actuation portions **948a-b** of FIG. 9 depending on which actuator is being actuated. In particular, the actuation portion **948a** cor-

responds to the second actuator being actuated, while the actuation portion **948b** corresponds to the first actuator being actuated. In this stage, the control matrix removes the holding voltage applied to both the first global update interconnect **832** and the second global update interconnect **833**. This is depicted in the actuation regions **948a-b** of the voltage graphs **904** and **905**. Based on the data voltage stored on the data store capacitor **854**, the pixel assumes either the first pixel state or the second pixel state. In some implementations, the pixel assumes the first pixel state by actuating the second actuator and conversely, the pixel assumes the second pixel state by actuating the first actuator. To actuate the second actuator, the data voltage stored on the data store capacitor **854** is high. Conversely, to actuate the first actuator, the data voltage stored on the data store capacitor **854** is low. Details regarding the operation of the control matrix **800** upon removing the holding voltage from the first global update interconnect **832** and the second global update interconnect **833** are provided below.

If the data voltage stored on the data store capacitor **854** is high and the holding voltage applied to the first global update interconnect **832** is removed, the first pre-charge discharge transistor **814** and the first actuation discharge transistor **824** are switched on. As a result, the pre-charge voltage at the pre-charge node **816** is drained, causing the pre-charge voltage at the first pre-charge node **816** to assume a low voltage state. Since the pre-charge voltage is low, the first actuation voltage transistor **822** is switched off. Further, the voltage at the first actuation node **826** is also drained causing the first actuation node **826** to assume a low voltage state as depicted in the actuation portion **948a** of the voltage graph **912**. As a result, the first actuator coupled to the first actuation node **826** is not actuated.

Furthermore, since the gates of the second pre-charge discharge transistor **864** and the second actuator discharge transistor **874** are coupled to the drain of the first actuator discharge transistor **824**, the voltage applied to the gates of the second pre-charge discharge transistor **864** and the second actuator discharge transistor **874** are low. As a result, the second pre-charge discharge transistor **864** and the second actuator discharge transistor **874** remain switched off regardless of the voltage applied to the second global update interconnect **833**. Since the second pre-charge discharge transistor **864** remains switched off, the pre-charge voltage at the second pre-charge node **866** remains high. The pre-charge voltage actuates the second actuation voltage transistor **872** and allows the actuation voltage from the actuation voltage interconnect **820** to pass through to the second actuation node **876**. This is depicted in the actuation portion **948a** of the voltage graph **913**. In this way, the second actuation node **876** assumes a high voltage state and the second actuator coupled to the second actuator node **876** is actuated. In this way, the pixel assumes the first pixel state.

Conversely, for the pixel to assume the second pixel state, the first actuation node **826** has to assume a high voltage state while the second actuation node **876** has to assume a low voltage state. As such, the data voltage stored on the data store capacitor **854** may be low as depicted in the data loading portion **944b** of the voltage graph **908**. In this way, upon removing the holding voltage applied to the first global update interconnect **832** and the second global update interconnect **833**, the first pre-charge discharge transistor **814** and the first actuation discharge transistor **824** remain switched off. As a result, the pre-charge voltage stored on the first pre-charge node **816** remains high causing the first actuation voltage transistor **822** to remain switched on. This allows the actuation voltage applied to the actuation voltage intercon-

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nect **820** to pass through the first actuation voltage transistor **822** to the first actuation node **826**. In this way, the first actuation node **826** assumes a high voltage state. As a result, the first actuator coupled to the first actuation node is actuated as depicted in the data loading portion **948B** of the voltage graph **912**.

Furthermore, since the gates of the second pre-charge discharge transistor **864** and the second actuator discharge transistor **874** are coupled to the drain of the first actuator discharge transistor **824**, the voltage applied to the gates of the second pre-charge discharge transistor **864** and the second actuator discharge transistor **874** are high. As a result, the second pre-charge discharge transistor **864** and the second actuator discharge transistor **874** are switched on. This causes the pre-charge voltage at the second pre-charge node **866** to drain. As a result, there is no pre-charge voltage being applied to the gate of the second actuation voltage transistor **872**, causing the second actuation voltage transistor **872** to switch off. Furthermore, the actuation voltage at the second actuation node **876** is also drained through the second actuation discharge transistor **874**. As a result, the voltage at the second actuation node becomes low as depicted in the actuation portion **948B** of the voltage graph **913**. In this way, the second actuator is switched off while the first actuator is actuated. As a result, the pixel assumes the first pixel state.

In some implementations, the holding voltage applied to the one of the first global update interconnect **832** and the second global update interconnect **833** is removed prior to removing the holding voltage applied to the other global update interconnect. This may prevent any current leakages causing the light modulators to operate unreliably. In some implementations, the delay between removing the holding voltages from the global update interconnects may be just large enough to allow the switches to settle. For instance, the delay may be about 10-20  $\mu$ s.

Once the pixel assumes the first pixel state or second pixel state, the control matrix **800** repeats the frame addressing and pixel actuation method for a subsequent frame or subframe. In some implementations, the pre-charge voltage stored on the pre-charge node is drained by switching on the one or more pre-charge discharge transistors. In some implementations, the control matrix repeats the frame addressing and pixel actuation method without discharging the pre-charged voltages stored on the control matrix **800**.

FIGS. **10A** and **10B** are system block diagrams illustrating a display device **40** that includes a plurality of display elements. The display device **40** can be, for example, a smart phone, a cellular or mobile telephone. However, the same components of the display device **40** or slight variations thereof are also illustrative of various types of display devices such as televisions, computers, tablets, e-readers, hand-held devices and portable media devices.

The display device **40** includes a housing **41**, a display **30**, an antenna **43**, a speaker **45**, an input device **48** and a microphone **46**. The housing **41** can be formed from any of a variety of manufacturing processes, including injection molding, and vacuum forming. In addition, the housing **41** may be made from any of a variety of materials, including, but not limited to: plastic, metal, glass, rubber and ceramic, or a combination thereof. The housing **41** can include removable portions (not shown) that may be interchanged with other removable portions of different color, or containing different logos, pictures, or symbols.

The display **30** may be any of a variety of displays, including a bi-stable or analog display, as described herein. The display **30** also can be configured to include a flat-panel display, such as plasma, electroluminescent (EL), organic

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light-emitting diode (OLED), super-twisted nematic liquid crystal display (STN LCD), or thin film transistor (TFT) LCD, or a non-flat-panel display, such as a cathode ray tube (CRT) or other tube device.

The components of the display device **40** are schematically illustrated in FIG. **10A**. The display device **40** includes a housing **41** and can include additional components at least partially enclosed therein. For example, the display device **40** includes a network interface **27** that includes an antenna **43** which can be coupled to a transceiver **47**. The network interface **27** may be a source for image data that could be displayed on the display device **40**. Accordingly, the network interface **27** is one example of an image source module, but the processor **21** and the input device **48** also may serve as an image source module. The transceiver **47** is connected to a processor **21**, which is connected to conditioning hardware **52**. The conditioning hardware **52** may be configured to condition a signal (such as filter or otherwise manipulate a signal). The conditioning hardware **52** can be connected to a speaker **45** and a microphone **46**. The processor **21** also can be connected to an input device **48** and a driver controller **29**. The driver controller **29** can be coupled to a frame buffer **28**, and to an array driver **22**, which in turn can be coupled to a display array **30**. One or more elements in the display device **40**, including elements not specifically depicted in FIG. **10A**, can be configured to function as a memory device and be configured to communicate with the processor **21**. In some implementations, a power supply **50** can provide power to substantially all components in the particular display device **40** design.

The network interface **27** includes the antenna **43** and the transceiver **47** so that the display device **40** can communicate with one or more devices over a network. The network interface **27** also may have some processing capabilities to relieve, for example, data processing requirements of the processor **21**. The antenna **43** can transmit and receive signals. In some implementations, the antenna **43** transmits and receives RF signals according to the IEEE 16.11 standard, including IEEE 16.11(a), (b), or (g), or the IEEE 802.11 standard, including IEEE 802.11a, b, g, n, and further implementations thereof. In some other implementations, the antenna **43** transmits and receives RF signals according to the Bluetooth® standard. In the case of a cellular telephone, the antenna **43** can be designed to receive code division multiple access (CDMA), frequency division multiple access (FDMA), time division multiple access (TDMA), Global System for Mobile communications (GSM), GSM/General Packet Radio Service (GPRS), Enhanced Data GSM Environment (EDGE), Terrestrial Trunked Radio (TETRA), Wideband-CDMA (W-CDMA), Evolution Data Optimized (EV-DO), 1xEV-DO, EV-DO Rev A, EV-DO Rev B, High Speed Packet Access (HSPA), High Speed Downlink Packet Access (HSDPA), High Speed Uplink Packet Access (HSUPA), Evolved High Speed Packet Access (HSPA+), Long Term Evolution (LTE), AMPS, or other known signals that are used to communicate within a wireless network, such as a system utilizing 3G, 4G or 5G technology. The transceiver **47** can pre-process the signals received from the antenna **43** so that they may be received by and further manipulated by the processor **21**. The transceiver **47** also can process signals received from the processor **21** so that they may be transmitted from the display device **40** via the antenna **43**.

In some implementations, the transceiver **47** can be replaced by a receiver. In addition, in some implementations, the network interface **27** can be replaced by an image source, which can store or generate image data to be sent to the processor **21**. The processor **21** can control the overall operation of the display device **40**. The processor **21** receives data,

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such as compressed image data from the network interface 27 or an image source, and processes the data into raw image data or into a format that can be readily processed into raw image data. The processor 21 can send the processed data to the driver controller 29 or to the frame buffer 28 for storage. Raw data typically refers to the information that identifies the image characteristics at each location within an image. For example, such image characteristics can include color, saturation and gray-scale level.

The processor 21 can include a microcontroller, CPU, or logic unit to control operation of the display device 40. The conditioning hardware 52 may include amplifiers and filters for transmitting signals to the speaker 45, and for receiving signals from the microphone 46. The conditioning hardware 52 may be discrete components within the display device 40, or may be incorporated within the processor 21 or other components.

The driver controller 29 can take the raw image data generated by the processor 21 either directly from the processor 21 or from the frame buffer 28 and can re-format the raw image data appropriately for high speed transmission to the array driver 22. In some implementations, the driver controller 29 can re-format the raw image data into a data flow having a raster-like format, such that it has a time order suitable for scanning across the display array 30. Then the driver controller 29 sends the formatted information to the array driver 22. Although a driver controller 29, such as an LCD controller, is often associated with the system processor 21 as a stand-alone Integrated Circuit (IC), such controllers may be implemented in many ways. For example, controllers may be embedded in the processor 21 as hardware, embedded in the processor 21 as software, or fully integrated in hardware with the array driver 22.

The array driver 22 can receive the formatted information from the driver controller 29 and can re-format the video data into a parallel set of waveforms that are applied many times per second to the hundreds, and sometimes thousands (or more), of leads coming from the display's x-y matrix of display elements. In some implementations, the array driver 22, and the display array 30 are a part of a display module. In some implementations, the driver controller 29, the array driver 22, and the display array 30 are a part of the display module.

In some implementations, the driver controller 29, the array driver 22, and the display array 30 are appropriate for any of the types of displays described herein. For example, the driver controller 29 can be a conventional display controller or a bi-stable display controller (such as the controller 134 described above with respect to FIG. 1). Additionally, the array driver 22 can be a conventional driver or a bi-stable display driver. Moreover, the display array 30 can be a conventional display array or a bi-stable display array (such as a display including an array of display elements, such as light modulator array 320 depicted in FIG. 3). In some implementations, the driver controller 29 can be integrated with the array driver 22. Such an implementation can be useful in highly integrated systems, for example, mobile phones, portable-electronic devices, watches or small-area displays.

In some implementations, the input device 48 can be configured to allow, for example, a user to control the operation of the display device 40. The input device 48 can include a keypad, such as a QWERTY keyboard or a telephone keypad, a button, a switch, a rocker, a touch-sensitive screen, a touch-sensitive screen integrated with the display array 30, or a pressure- or heat-sensitive membrane. The microphone 46 can be configured as an input device for the display device 40.

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In some implementations, voice commands through the microphone 46 can be used for controlling operations of the display device 40.

The power supply 50 can include a variety of energy storage devices. For example, the power supply 50 can be a rechargeable battery, such as a nickel-cadmium battery or a lithium-ion battery. In implementations using a rechargeable battery, the rechargeable battery may be chargeable using power coming from, for example, a wall socket or a photo-voltaic device or array. Alternatively, the rechargeable battery can be wirelessly chargeable. The power supply 50 also can be a renewable energy source, a capacitor, or a solar cell, including a plastic solar cell or solar-cell paint. The power supply 50 also can be configured to receive power from a wall outlet.

In some implementations, control programmability resides in the driver controller 29 which can be located in several places in the electronic display system. In some other implementations, control programmability resides in the array driver 22. The above-described optimization may be implemented in any number of hardware and/or software components and in various configurations.

The various illustrative logics, logical blocks, modules, circuits and algorithm processes described in connection with the implementations disclosed herein may be implemented as electronic hardware, computer software, or combinations of both. The interchangeability of hardware and software has been described generally, in terms of functionality, and illustrated in the various illustrative components, blocks, modules, circuits and processes described above. Whether such functionality is implemented in hardware or software depends upon the particular application and design constraints imposed on the overall system.

The hardware and data processing apparatus used to implement the various illustrative logics, logical blocks, modules and circuits described in connection with the aspects disclosed herein may be implemented or performed with a general purpose single- or multi-chip processor, a digital signal processor (DSP), an application specific integrated circuit (ASIC), a field programmable gate array (FPGA) or other programmable logic device, discrete gate or transistor logic, discrete hardware components, or any combination thereof designed to perform the functions described herein. A general purpose processor may be a microprocessor, or, any conventional processor, controller, microcontroller, or state machine. A processor also may be implemented as a combination of computing devices, e.g., a combination of a DSP and a microprocessor, a plurality of microprocessors, one or more microprocessors in conjunction with a DSP core, or any other such configuration. In some implementations, particular processes and methods may be performed by circuitry that is specific to a given function.

In one or more aspects, the functions described may be implemented in hardware, digital electronic circuitry, computer software, firmware, including the structures disclosed in this specification and their structural equivalents thereof, or in any combination thereof. Implementations of the subject matter described in this specification also can be implemented as one or more computer programs, i.e., one or more modules of computer program instructions, encoded on a computer storage media for execution by, or to control the operation of, data processing apparatus.

If implemented in software, the functions may be stored on or transmitted over as one or more instructions or code on a computer-readable medium. The processes of a method or algorithm disclosed herein may be implemented in a processor-executable software module which may reside on a com-

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puter-readable medium. Computer-readable media includes both computer storage media and communication media including any medium that can be enabled to transfer a computer program from one place to another. A storage media may be any available media that may be accessed by a computer. By way of example, and not limitation, such computer-readable media may include RAM, ROM, EEPROM, CD-ROM or other optical disk storage, magnetic disk storage or other magnetic storage devices, or any other medium that may be used to store desired program code in the form of instructions or data structures and that may be accessed by a computer. Also, any connection can be properly termed a computer-readable medium. Disk and disc, as used herein, includes compact disc (CD), laser disc, optical disc, digital versatile disc (DVD), floppy disk, and Blu-ray disc where disks usually reproduce data magnetically, while discs reproduce data optically with lasers. Combinations of the above should also be included within the scope of computer-readable media. Additionally, the operations of a method or algorithm may reside as one or any combination or set of codes and instructions on a machine readable medium and computer-readable medium, which may be incorporated into a computer program product.

Various modifications to the implementations described in this disclosure may be readily apparent to those skilled in the art, and the generic principles defined herein may be applied to other implementations without departing from the spirit or scope of this disclosure. Thus, the claims are not intended to be limited to the implementations shown herein, but are to be accorded the widest scope consistent with this disclosure, the principles and the novel features disclosed herein.

Additionally, a person having ordinary skill in the art will readily appreciate, the terms “upper” and “lower” are sometimes used for ease of describing the figures, and indicate relative positions corresponding to the orientation of the figure on a properly oriented page, and may not reflect the proper orientation of any device as implemented.

Certain features that are described in this specification in the context of separate implementations also can be implemented in combination in a single implementation. Conversely, various features that are described in the context of a single implementation also can be implemented in multiple implementations separately or in any suitable subcombination. Moreover, although features may be described above as acting in certain combinations and even initially claimed as such, one or more features from a claimed combination can in some cases be excised from the combination, and the claimed combination may be directed to a subcombination or variation of a subcombination.

Similarly, while operations are depicted in the drawings in a particular order, this should not be understood as requiring that such operations be performed in the particular order shown or in sequential order, or that all illustrated operations be performed, to achieve desirable results. Further, the drawings may schematically depict one more example processes in the form of a flow diagram. However, other operations that are not depicted can be incorporated in the example processes that are schematically illustrated. For example, one or more additional operations can be performed before, after, simultaneously, or between any of the illustrated operations. In certain circumstances, multitasking and parallel processing may be advantageous. Moreover, the separation of various system components in the implementations described above should not be understood as requiring such separation in all implementations, and it should be understood that the described program components and systems can generally be integrated together in a single software product or packaged

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into multiple software products. Additionally, other implementations are within the scope of the following claims. In some cases, the actions recited in the claims can be performed in a different order and still achieve desirable results.

What is claimed is:

1. An apparatus, comprising:

a plurality of display elements arranged in an array; and  
a control matrix coupled to the plurality of display elements to communicate data and drive voltages to the display elements,

wherein the control matrix, for each display element, includes:

an actuation circuit coupling a voltage source to a respective display element and configured to apply an actuation voltage to an actuator of the respective display element throughout an actuation stroke of the actuator; and

wherein the control matrix is configured to initiate the actuation of the actuator after a pre-charging signal that initiated the application of the actuation voltage to the actuator has been deactivated.

2. The apparatus of claim 1, wherein the actuation circuit is coupled to a global update interconnect and the actuation circuit is configured to selectively remove the actuation voltage applied to the actuator in response to activation of the global update interconnect.

3. The apparatus of claim 2, wherein the actuation circuit includes a source follower circuit.

4. The apparatus of claim 2, wherein the actuation circuit includes an actuation discharge transistor coupled to the global update interconnect, and the actuation voltage is removed by being discharged through the actuation discharge transistor.

5. The apparatus of claim 4, wherein the actuation discharge transistor is selectively activated based on a data voltage stored at the data store.

6. The apparatus of claim 1, wherein the actuation circuit is coupled to a pre-charge node and controlled by the pre-charging signal on the pre-charge node, the pre-charge node coupled to a pre-charge voltage source that provides the pre-charging signal.

7. The apparatus of claim 6, wherein the pre-charge voltage on the pre-charge node for the display element is controlled by the pre-charge signal voltage source and a pre-charge discharge switch that maintains the voltage on the pre-charge node provided by the pre-charge signal voltage source until the pre-charge discharge switch is activated.

8. The apparatus of claim 1, wherein the control matrix, for each display element, includes a second actuation circuit coupling the voltage source to the respective display element and configured to apply the actuation voltage to a second actuator of the respective display element throughout a second actuation stroke of the actuator in a direction different from the first actuation stroke; and wherein the control matrix is configured to initiate the actuation of the second actuator after a second pre-charging signal that initiated the application of the actuation voltage to the second actuator has been deactivated.

9. The apparatus of claim 8, wherein the second actuation circuit is coupled to a second global update interconnect, wherein the control matrix is configured to actuate one of the actuator and the second actuator by activating one of the global update interconnect and the second global update interconnect prior to activating the other of the global update interconnect and the second global update interconnect.

10. The apparatus of claim 9, wherein the second actuation circuit configured to selectively remove the actuation voltage

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applied to the second actuator in response to activation of the second global update interconnect.

11. The apparatus of claim 10, wherein the actuation circuit includes an actuation discharge transistor coupled to the second global update interconnect, and the actuation voltage is removed by being discharged through the actuation discharge transistor.

12. The apparatus of claim 11, wherein the second actuation discharge transistor is selectively activated based on an output of the actuation discharge transistor.

13. The apparatus of claim 1, wherein the control matrix includes only n-type transistors.

14. The apparatus of claim 1, wherein the control matrix includes only p-type transistors.

15. The apparatus of claim 1, wherein the apparatus includes a display apparatus and the display elements include light modulators.

16. The apparatus of claim 1, wherein the display elements include electromechanical system (EMS) display elements.

17. The apparatus of claim 1, wherein the display elements include microelectromechanical system (MEMS) display elements.

18. The apparatus of claim 1, further comprising:  
a display including the array of display elements;  
a processor that is configured to communicate with the display, the processor being configured to process image data; and  
a memory device that is configured to communicate with the processor.

19. The apparatus of claim 18, further comprising:  
a driver circuit configured to send at least one signal to the display; and wherein  
the controller further configured to send at least a portion of the image data to the driver circuit.

20. The apparatus of claim 19, further comprising:  
an image source module configured to send the image data to the processor, wherein the image source module comprises at least one of a receiver, transceiver, and transmitter.

21. The apparatus of claim 20, further comprising:  
an input device configured to receive input data and to communicate the input data to the processor.

22. The apparatus of claim 18, wherein the display elements include light modulators.

23. An apparatus, comprising:  
a plurality of display elements arranged in an array; and  
a control matrix coupled to the plurality of display elements to communicate data and drive voltages to the display elements,

wherein the control matrix, for each display element, includes:

a first actuation circuit coupling a voltage source to a respective display element and configured to apply an

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actuation voltage to a first actuator of the respective display element throughout an actuation stroke of the first actuator;

a second actuation circuit coupling the voltage source to the display element and configured to apply the actuation voltage to a second actuator of the display element throughout an actuation stroke of the second actuator; and

wherein the control matrix is configured to initiate the actuation of one of the first actuator and the second actuator after a pre-charging signal that initiated the application of the actuation voltage to the first actuator and the second actuator has been deactivated.

24. The apparatus of claim 23, wherein the first actuation circuit is coupled to a first global update interconnect and the first actuation circuit is configured to selectively remove the actuation voltage applied to the first actuator in response to deactivation of the first global update interconnect; and wherein the second actuation circuit is coupled to a second global update interconnect and the second actuation circuit is configured to selectively remove the actuation voltage applied to the first actuator in response to deactivation of the second global update interconnect.

25. The apparatus of claim 24, wherein the control matrix is configured to actuate one of the first actuator and the second actuator in response to the deactivation of one of the first global update interconnect and the second global update interconnect prior to the deactivation of the other of the first global update interconnect and the second global update interconnect.

26. The apparatus of claim 25, wherein the control matrix is configured to actuate one of the first actuator and the second actuator based on a data voltage stored at a data store capacitor.

27. The apparatus of claim 23, wherein the first actuator circuit and the second actuator circuit are governed by the pre-charging signal on a pre-charge node, the pre-charge node coupled to a pre-charge voltage source that activates the pre-charging signal.

28. The apparatus of claim 23, wherein the control matrix includes only n-type transistors.

29. The apparatus of claim 23, wherein the control matrix includes only p-type transistors.

30. The apparatus of claim 23, wherein the apparatus includes a display apparatus and the display elements include light modulators.

31. The apparatus of claim 23, wherein the display elements include electromechanical system (EMS) display elements.

32. The apparatus of claim 23, wherein the display elements include microelectromechanical system (MEMS) display elements.

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